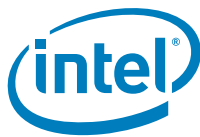


# **Intel® 82575EB Gigabit Ethernet Controller Datasheet**

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**LAN Access Division**

317679-004  
Revision: 2.11  
January 2011



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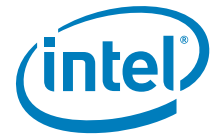
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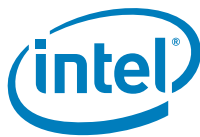
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## Revisions

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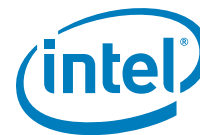
| Date       | Revision | Description                                                                                                                                                                                                                                                                                                                                                                         |
|------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8/2005     | 0.10     | Initial Release                                                                                                                                                                                                                                                                                                                                                                     |
| 1/2006     | 0.25     | Added general information, updated pins list                                                                                                                                                                                                                                                                                                                                        |
| 7/2006     | 0.50     | Removed information regarding Fast Management Link; added general information                                                                                                                                                                                                                                                                                                       |
| 2/2007     | 0.75     | Added measured power values; corrected Visual Pin Assignment Diagrams (RBIAS0_N and RBIAS1_N corrected to VSS).                                                                                                                                                                                                                                                                     |
| 6/2007     | 1.0      | Updated classification, changed RMII to NC-SI, updated pin list, updated NC-SI timing specs. changed LAN_PWR_GOOD to Internal_Power_On_Reset.                                                                                                                                                                                                                                       |
| 12/13/2010 | 2.0      | <a href="#">Section 2.1, PCI Express Features</a> - Support for x4, x2, and x1 modes now indicated.<br><a href="#">Section 3.5, MDIO Signals</a> - MDC pin now listed as type 0.<br><a href="#">Section 3.7, LED Signals</a> - Introductory note updated.<br><a href="#">Section 9.2, Pin Map</a> - Corrected information applicable to pins AC5, AC16, AC17, AD16, AD17, B12, K14. |
| 1/28/2011  | 2.1      | Update Doc title to match brand string.<br><a href="#">Table 7, DC Characteristics</a> - VCC(1.0) row updated. See bold.                                                                                                                                                                                                                                                            |
| 1/28/2011  | 2.11     | Build issue corrected.                                                                                                                                                                                                                                                                                                                                                              |



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## 1.0 Introduction

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The Intel® 82575EB Gigabit Ethernet Controller is a single, compact component with two fully integrated Gigabit Ethernet Media Access Control (MAC) and physical layer (PHY) ports. The device uses the PCI Express Base Specification, Rev.1.1RD.

The 82575EB provides a standard IEEE 802.3 Ethernet interface for 1000BASE-T, 100BASE-TX, and 10BASE-T applications (802.3z, 802.3u, and 802.3ab). Ports also contain a Serializer-Deserializer (SERDES) to support 1000Base-SX/LX (optical fiber) and Gigabit backplane applications. In addition to managing MAC and PHY Ethernet layer functions, the controller manages PCI Express packet traffic across its transaction, link, and physical/logical layers. The SERDES can be used in SGMII mode to connect to external PHY, either on-board or via the SFP connector.

The Intel 82575EB's on-board System Management Bus (SMB) ports enable network manageability implementations required by information technology personnel for remote control and alerting via the LAN. With SMB, management packets can be routed to or from a management processor. Enhanced pass-through capabilities also allow system remote control over standardized interfaces. Also included is a new manageability interface, NC-SI that supports the DMTF preOS sideband protocol. An internal management interface called MDIO enables the MAC (and software) to monitor and control the PHY. Both ports support the Wake on LAN feature.

The 82575EB with PCI Express architecture is designed for high performance and low memory latency. The device is optimized to connect to a system Memory Control Hub (MCH) using four PCI Express lanes. Alternatively, the 82575EB can connect to an I/O Control Hub that has a PCI Express interface.

Wide internal data paths eliminate performance bottlenecks by efficiently handling large address and data words. Combining a parallel and pipe-lined logic architecture optimized for Gigabit Ethernet and independent transmit and receive queues, the 82575EB efficiently handles packets with minimum latency. The 82575EB includes advanced interrupt handling features, including MSI-X support. The 82575EB uses efficient ring buffer descriptor data structures, with up to 64 packet descriptors cached on chip. A large 48 KByte per port on-chip packet buffer maintains superior performance. In addition, using hardware acceleration, the controller offloads tasks from the host, such as TCP/UDP/IP checksum calculations and TCP segmentation.

The 82575EB operation can be configured using EEPROM and FLASH; it can be also be used in EEPROM-less configurations.

The 82575EB is packaged in a 25mm X 25mm, 576-pin flip chip ball grid array (FCBGA).

### 1.1 Document Scope

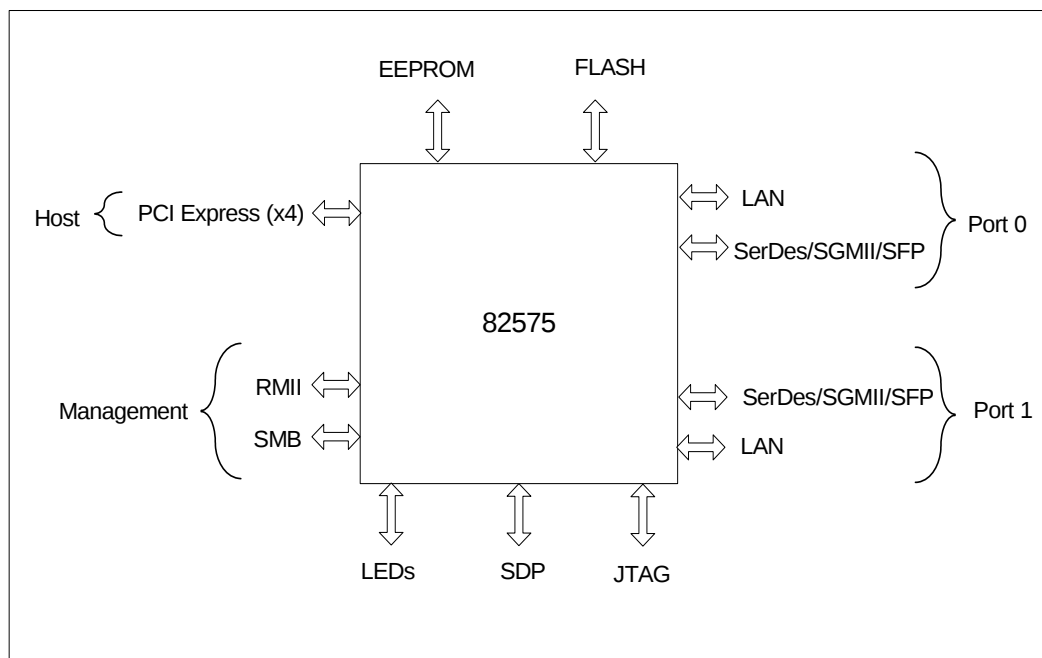
This document contains targeted datasheet specifications for the 82575EB, including signal descriptions, DC and AC parameters, packaging data, and pinout information.

## 1.2 References

The primary references include the following manuals:

- Intel® 82575EB Gigabit Controller Datasheet
- Intel® 82575EB Gigabit Controller Design Guide
- Intel® 82575EB Gigabit Controller Manageability
- Intel® 82575EB Gigabit Controller Software Developer's Manual and EEPROM Guide
- Intel® 82575EB Gigabit Controller Thermal Design Considerations
- Intel® 82575EB Gigabit Controller Specification Update

## 1.3 Block Diagram



**Figure 1. 82575EB Gigabit Ethernet Controller Block Diagram**



## 2.0 Features of the 82575EB Gigabit Ethernet Controller

### 2.1 PCI Express Features

| Features                                                                       | Benefits                                                                                                                                                                          |
|--------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Uses x4 PCI Express interface on MCH device.<br>Supports x4, x2, and x1 modes. | <ul style="list-style-type: none"> <li>• Bus sharing not required</li> <li>• Low latency path to memory</li> <li>• Relieves congestion for IO devices connected to ICH</li> </ul> |
| Peak bandwidth 2 GB/s in each direction per PCI Express lane                   | <ul style="list-style-type: none"> <li>• Supports Gigabit Ethernet at full wire speed</li> </ul>                                                                                  |
| PCI Express Power Management                                                   | <ul style="list-style-type: none"> <li>• Compatible extensions to PCI power management and ACPI</li> <li>• PE_WAKE available for wakeup event</li> </ul>                          |
| High bandwidth density per pin                                                 | <ul style="list-style-type: none"> <li>• Less congested board routing</li> </ul>                                                                                                  |
| 64-bit address support for systems using more than 4 GB of physical memory     |                                                                                                                                                                                   |

### 2.2 MAC-Specific Features

| Features                                                                                                      | Benefits                                                                                                                                                                                       |
|---------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| I/O Acceleration Technology <sup>2</sup> (IOAT <sup>2</sup> )                                                 | <ul style="list-style-type: none"> <li>• Accelerated TCP I/O.</li> </ul>                                                                                                                       |
| Four optimized transmit and receive queues                                                                    | <ul style="list-style-type: none"> <li>• Network packets handled without waiting or buffer overflow.</li> </ul>                                                                                |
| IEEE 802.3x compliant flow control support with software controllable pause times and threshold values        | <ul style="list-style-type: none"> <li>• Control over the transmissions of pause frames through software or hardware triggering</li> <li>• Frame loss reduced from receive overruns</li> </ul> |
| Caches up to 64 packet descriptors (per queue)                                                                | <ul style="list-style-type: none"> <li>• Efficient use of PCI Express bandwidth</li> </ul>                                                                                                     |
| Separate transmit and receive queues per port                                                                 | <ul style="list-style-type: none"> <li>• Efficient packet prioritization</li> </ul>                                                                                                            |
| Programmable host memory receive buffers (256 Bytes to 16 KBytes) and cache line size (64 Bytes to 128 Bytes) | <ul style="list-style-type: none"> <li>• Efficient use of PCI Express bandwidth</li> </ul>                                                                                                     |
| Wide, pipelined internal data path architecture                                                               | <ul style="list-style-type: none"> <li>• Low latency data handling</li> <li>• Superior DMA transfer rate performance</li> </ul>                                                                |
| Dual 8 KByte configurable Transmit and Receive FIFO buffers                                                   | <ul style="list-style-type: none"> <li>• No external FIFO memory requirements</li> <li>• FIFO size adjustable to application</li> </ul>                                                        |
| Descriptor ring management hardware for transmit and receive                                                  | <ul style="list-style-type: none"> <li>• Simple software programming model</li> </ul>                                                                                                          |
| Optimized descriptor fetching and write-back mechanisms                                                       | <ul style="list-style-type: none"> <li>• Efficient system memory and use of PCI Express bandwidth</li> </ul>                                                                                   |
| Mechanism available for reducing interrupts generated by transmit and receive operations                      | <ul style="list-style-type: none"> <li>• Maximizes system performance and throughput</li> </ul>                                                                                                |



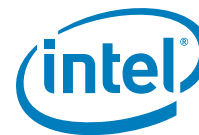
| Features                                                       | Benefits                                                                                                                                                   |
|----------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Support for transmission and reception of packets up to 9.5 kB | <ul style="list-style-type: none"><li>Enables jumbo frames</li></ul>                                                                                       |
| MSI-X Support                                                  | <ul style="list-style-type: none"><li>Part of the PCI standard, enables sending interrupt messages to specific CPUs in a multiple-cores platform</li></ul> |

## 2.3 PHY-Specific Features

| Features                                                                                                                                  | Benefits                                                                                                                           |
|-------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------|
| IEEE 802.3x compliant flow control support with software controllable pause times and threshold values                                    | Control over the transmissions of pause frames through software or hardware triggering<br>Frame loss reduced from receive overruns |
| Line Length >140m                                                                                                                         | Reliable operation at greater distances                                                                                            |
| Operates with worst-case cable                                                                                                            | Reliability                                                                                                                        |
| Supports carrier extension and packet bursting (half duplex)                                                                              | Improves performance                                                                                                               |
| Auto-negotiation with support for Next Page                                                                                               | Improves performance and reliability                                                                                               |
| PMA loopback capable (No echo cancel)                                                                                                     | Facilitates testing/troubleshooting                                                                                                |
| Advanced Power Management - <ul style="list-style-type: none"><li>Low power link up</li><li>"Smart Power Down - Link disconnect</li></ul> | Improves power capabilities                                                                                                        |
| Support for limited auto MDIO register init - limited number of registers                                                                 | Improves performance                                                                                                               |
| Fiber/Copper switch support                                                                                                               | Ease of design                                                                                                                     |
| SERDES Signal Detect and support of non-AN partner                                                                                        |                                                                                                                                    |
| Smart Speed                                                                                                                               |                                                                                                                                    |
| Auto crossover for MDI                                                                                                                    |                                                                                                                                    |
| Smart Power Down                                                                                                                          |                                                                                                                                    |
| Advanced Cable Diagnostics                                                                                                                |                                                                                                                                    |

## 2.4 Host Offloading Features

| Features                                                               | Benefits                                                                                                                                                                 |
|------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Transmit and receive IP, TCP and UDP checksum off-loading capabilities | <ul style="list-style-type: none"><li>Lower CPU utilization</li></ul>                                                                                                    |
| Transmit TCP segmentation                                              | <ul style="list-style-type: none"><li>Increased throughput and lower CPU utilization</li><li>Large send offload feature (in Microsoft* Windows* XP) compatible</li></ul> |
| IPv6 Offloading                                                        | <ul style="list-style-type: none"><li>Checksum and segmentation capability extended to new standard packet type</li></ul>                                                |
| Header split replication in receive                                    | <ul style="list-style-type: none"><li>Helps the driver to focus on the relevant part of the packet without the need to parse it.</li></ul>                               |



| Features                                                                                                  | Benefits                                                                                                                                                                                                                                                              |
|-----------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Advanced packet filtering                                                                                 | <ul style="list-style-type: none"> <li>16 exact matched packets (unicast or multicast)</li> <li>4096-bit hash filter for multicast frames</li> <li>Promiscuous (unicast and multicast) transfer mode support</li> <li>Optional filtering of invalid frames</li> </ul> |
| IEEE 802.1q VLAN support with VLAN tag insertion, stripping and packet filtering for up to 4096 VLAN tags | <ul style="list-style-type: none"> <li>Ability to create multiple virtual LAN segments</li> </ul>                                                                                                                                                                     |
| Double Vlan                                                                                               | <ul style="list-style-type: none"> <li>Insert in Tx and extract in Rx</li> </ul>                                                                                                                                                                                      |
| Descriptor ring management hardware for transmit and receive                                              | <ul style="list-style-type: none"> <li>Optimized fetching and write-back mechanisms for efficient system memory and PCI bandwidth usage</li> </ul>                                                                                                                    |
| 9.5 kByte jumbo frame support                                                                             | <ul style="list-style-type: none"> <li>High throughput for large data transfers on networks supporting jumbo frames</li> </ul>                                                                                                                                        |
| Receive Side Scaling (RSS)                                                                                | <ul style="list-style-type: none"> <li>Multiple Rx queues</li> </ul>                                                                                                                                                                                                  |
| VMDq                                                                                                      | <ul style="list-style-type: none"> <li>Virtualization environment. In this environment, packets dedicated to different virtual machines can be routed to different queues, thus easing the routing of these packets to the target machine.</li> </ul>                 |
| Direct Cache Access (DCA)                                                                                 | <ul style="list-style-type: none"> <li>The IO device activates a pre-fetch engine in the CPU that loads the data into the CPU cache ahead of time, before use, eliminating cache misses and reducing CPU load.</li> </ul>                                             |
| Fragmented UDP checksum offload for packet reassembly                                                     | <ul style="list-style-type: none"> <li></li> </ul>                                                                                                                                                                                                                    |

## 2.5 Manageability Features

| Features                                                                                                                                                                                                                          | Benefits                                                                                                                        |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|
| Advance Pass Through-compatible management packet Tx/Rx support                                                                                                                                                                   |                                                                                                                                 |
| Alert on LAN 2.0                                                                                                                                                                                                                  |                                                                                                                                 |
| Both ports support Wake on LAN (WoL)                                                                                                                                                                                              |                                                                                                                                 |
| SMBus port                                                                                                                                                                                                                        | Network management flexibility                                                                                                  |
| NC-SI high-bandwidth interface                                                                                                                                                                                                    | Manageability DMTF preOS sideband protocol support                                                                              |
| On-board microcontroller                                                                                                                                                                                                          | Promotes customized designs<br>Allows packets routing to and from either LAN port and a server management processor             |
| Preboot eXecution Environment (PXE) Flash interface support (32-bit and 64-bit)                                                                                                                                                   | Local Flash interface for PXE image                                                                                             |
| iSCSI Boot                                                                                                                                                                                                                        | Network Management Feature                                                                                                      |
| Compliance with PCI Power Management 1.1 and ACPI 2.0 register set compliant including: <ul style="list-style-type: none"> <li>D0 and D3 power states</li> <li>Network Device Class Power Management Specification 1.1</li> </ul> | PCI power management capability requirements for PC and embedded applications                                                   |
| SNMP and RMON statistic counters                                                                                                                                                                                                  | Easy system monitoring with industry standard consoles                                                                          |
| SDG 3.0, WfM 3.0, and PC2001 compliance                                                                                                                                                                                           | Remote network management capabilities through DMI 2.0 and SNMP software                                                        |
| Watchdog Timer                                                                                                                                                                                                                    | Used to give an indication to the manageability firmware or external devices that the 82575EB or the driver is not functioning. |
| SGMII interface for embedded applications with an I2C or MDC/MDIO control interface.                                                                                                                                              | Ease of embedded designs                                                                                                        |



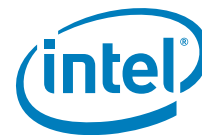
## 2.6 Additional Device Features

| Features                                                                      | Benefits                                                                                                                                                                                                                                                                                                                                                          |
|-------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Two complete Gigabit Ethernet connections in a single device                  | <ul style="list-style-type: none"><li>• Inherent dual port teaming ability</li><li>• High availability using one port for failover</li><li>• Higher throughput than single Gigabit Ethernet port</li><li>• Lower latency due to one electrical load on the bus</li><li>• Saves critical board space</li><li>• Reduced multi-port Gigabit Ethernet costs</li></ul> |
| Integrated SERDES                                                             | <ul style="list-style-type: none"><li>• Supports backplane and fiber applications as well as copper-based Gigabit via the SGMII interface</li></ul>                                                                                                                                                                                                               |
| Four activity and link indication outputs (per port) that directly drive LEDs | <ul style="list-style-type: none"><li>• Link and activity indications (10, 100, and 1000 Mbps) on each port</li></ul>                                                                                                                                                                                                                                             |
| Programmable LED functionality                                                | <ul style="list-style-type: none"><li>• Software definable function (speed, link, and activity) and blinking allowing flexible LED implementations</li></ul>                                                                                                                                                                                                      |
| Internal PLL for clock generation can use a 25 MHz crystal                    | <ul style="list-style-type: none"><li>• Lower component count and system cost</li></ul>                                                                                                                                                                                                                                                                           |
| JTAG (IEEE 1149.1) Test Access Port built in silicon                          | <ul style="list-style-type: none"><li>• Simplified testing using boundary scan</li><li>• Supports the IDCODE instruction</li></ul>                                                                                                                                                                                                                                |
| Four software definable pins per port                                         | <ul style="list-style-type: none"><li>• Additional flexibility for LEDs or other low speed I/O devices</li></ul>                                                                                                                                                                                                                                                  |
| Provides loopback capabilities                                                | <ul style="list-style-type: none"><li>• Validates silicon integrity</li></ul>                                                                                                                                                                                                                                                                                     |
| Four-wire SPI EEPROM interface                                                | <ul style="list-style-type: none"><li>• Standard</li></ul>                                                                                                                                                                                                                                                                                                        |

## 2.7 Technology Features

| Features                                                                                                                                           | Benefits                                                                                                                                                                          |
|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 576-pin Flip-Chip Ball Grid Array (FC-BGA) package                                                                                                 | <ul style="list-style-type: none"><li>• 25 mm X 25 mm</li></ul>                                                                                                                   |
| Operating temperature:<br>1000BASE-T, 0 °C to 55 °C*<br>1000BASE-SX/LX (or SERDES backplane), 0 °C to 70 °C<br>Storage temperature 65 °C to 140 °C | <ul style="list-style-type: none"><li>• Simple thermal design</li></ul>                                                                                                           |
| Typical targeted power dissipation:<br>2.43 W @ D0 1000 Mbps<br>0.79 W @ D3cold 100 Mbps (wakeup enabled)<br>0.29 W @ D3cold (wakeup disabled)     | <ul style="list-style-type: none"><li>• Conditions: FF materials, nominal voltage, 115 °C</li><li>• Minimizes impact of incorporating Gigabit instead of Fast Ethernet.</li></ul> |
| Maximum Payload Size: 128 and 256                                                                                                                  |                                                                                                                                                                                   |
| Max number of transactions (TLP) supported on PCIe: Four TX DMA requests + 1 TX descriptor + 1 RX descriptor.                                      |                                                                                                                                                                                   |

\* For information about operating the 82575EB outside of this range, please refer to the 82575EB Thermal Management Application Note.



## 3.0 Signal Descriptions and Pinout List

The targeted signal names are subject to change without notice. Verify with your local Intel sales office that you have the latest information before finalizing a design.

### 3.1 Signal Type Definitions

The signals of the 82575EB are electrically defined as follows:

| Name | Definition                                                                                                                                                                                                                                                                                 | DC specification |
|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|
| I    | Input<br>Standard input only digital signal.                                                                                                                                                                                                                                               | See Table 9      |
| O    | Output<br>Standard output only digital signal.                                                                                                                                                                                                                                             | See Table 9      |
| TS   | Tri-state<br>Bi-directional three-state digital input/output signal.                                                                                                                                                                                                                       | See Table 9      |
| OD   | Open Drain<br>Wired-OR with other agents.<br><br>The signaling agent asserts the OD signal, but the signal is returned to the inactive state by a weak pull-up resistor. The pull-up resistor may require two or three clock periods to fully restore the signal to the de-asserted state. | See Table 10     |
| A    | Analog<br>PCI Express*, SERDES, or PHY analog signal.                                                                                                                                                                                                                                      | See Table 10     |
| P    | Power<br>Power connection, voltage reference, or other reference connection.                                                                                                                                                                                                               | See Table 10     |

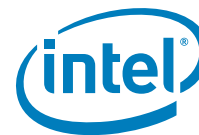


## 3.2 PCI Express Interface

| Symbol                                                                               | Type | Name and Function                                                                                                                                                                                                                                                                                        |
|--------------------------------------------------------------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PER_0_N<br>PER_0_P<br>PER_1_N<br>PER_1_P<br>PER_2_N<br>PER_2_P<br>PER_3_N<br>PER_3_P | A(I) | High Speed Serial Receive Data<br><br>These signals connect to corresponding PETn and PETp signals on a system motherboard or a PCI Express connector. Series AC coupling capacitors are required at the transmitter end. The PCI Express differential inputs are clocked at 2.5 Gb/s.                   |
| PET_0_N<br>PET_0_P<br>PET_1_N<br>PET_1_P<br>PET_2_N<br>PET_2_P<br>PET_3_N<br>PET_3_P | A(0) | High Speed Serial Transmit Data<br><br>These signals connect to corresponding PERn and PERp signals on a system motherboard or a PCI Express connector. Series AC coupling capacitors are required at the 82575EB end. The PCI Express differential outputs are clocked at 2.5 Gb/s.                     |
| PE_RCOMP                                                                             | A    | High Speed Serial Impedance Compensation<br><br>Connect the recommended resistor value 1.4K $\Omega$ from this ball to ground.                                                                                                                                                                           |
| PE_CLK_P<br>PE_CLK_N                                                                 | A    | 100 MHz Differential Clock for the PCI Express Interface<br><br>The reference clock is furnished by the system and has a 300 ppm frequency tolerance.                                                                                                                                                    |
| PE_RST_N                                                                             | I    | PCI Express Reset<br><br>When the signal is low, all PCI Express functions are held in reset. When the signal is high, it denotes that main power is available to the 82575EB and the reference clock is running.<br><br>In systems with a PCI Express add-in card, this signal routes to the connector. |
| PE_WAKE_N                                                                            | OD   | Wake<br><br>The device drives this signal low when it receives a wake-up event and either the PME Enable bit in the Power Management Control/Status Register or the Advanced Power Management Enable (APME) bit of the Wake-up Control Register (WUC) is 1b.                                             |

## 3.3 Power Management Signals

| Symbol                   | Type | Name and Function                                                                                                                                                                       |
|--------------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AUX_PWR                  | I    | Auxiliary Power Present.<br><br>If the Auxiliary Power signal is high, then auxiliary power is present and the 82575device should support the D3 <sub>cold</sub> power state.           |
| LAN0_DIS_N<br>LAN1_DIS_N | I    | LAN Disables 0 and 1<br><br>Disables individual Ethernet ports. State is latched upon a rising edge of PERST_N or a PCI Express reset event. This pin has an internal pull-up resistor. |
| DEV_OFF_N                | I    | Device Off<br><br>Asynchronously disables Ethernet controller.                                                                                                                          |
| MAIN_PWR_OK              | I    | Main Power OK<br><br>Indicates that platform main power is up. Must be connected externally.                                                                                            |



## 3.4 System Management Interface Signals

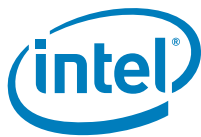
| Symbol                     | Type | Name and Function                                                                                                                                                                                               |
|----------------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SMBCLK                     | OD   | SMB Clock<br>The SMB Clock signal is an open drain signals for the serial SMB interface.                                                                                                                        |
| SMBD                       | OD   | SMB Data<br>The SMB Data signal is an open drain signal for the serial SMB interface.                                                                                                                           |
| SMBALRT_N                  | OD   | SMB Alert<br>The SMB Alert signal is an open drain signal for serial SMB Port A. It acts as an alert input in 82559 compatible mode.                                                                            |
| NCSI_CLK_IN                | I    | NCSI Reference Clock Input. Synchronous clock reference for receive, transmit and control interface. It is a 50MHz clock +/- 50 ppm.                                                                            |
| NCSI_CLK_OUT               | O    | NCSI Reference Clock Output. Synchronous clock reference for receive, transmit and control interface. It is a 50MHz clock +/- 50 ppm. Serves as a clock source to the BMC and the 82575EB (when configured so). |
| NCSI_CRS_DV                | O    | Carrier Sense / Receive Data Valid                                                                                                                                                                              |
| NCSI_RXD[1]<br>NCSI_RXD[0] | O    | Receive Data. Data signals from the device to the BMC                                                                                                                                                           |
| NCSI_TX_EN                 | I    | Transmit Enable                                                                                                                                                                                                 |
| NCSI_TXD[1]<br>NCSI_TXD[0] | I    | Transmit Data. Data signals from BMC to the device                                                                                                                                                              |

## 3.5 MDIO Signals

| Symbol | Type | Name and Function                                                                                                                                                                                                                                                                                                                                                                                                                   |
|--------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MDC    | O    | Management Data Clock. Used by the PHY as a clock timing reference for information transfer on the MDIO signal. The MDC is not required to be a continuous signal and can be frozen when no management data is transferred. The MDC signal has a maximum operating frequency of 2.5MHz.                                                                                                                                             |
| MDIO   | I/O  | Management Data I/O. This internal signaling between the MAC and PHY logically represents a bi-directional data signal used to transfer control information and status to and from the PHY (to read and write the PHY management registers). Asserting and interpreting value(s) on this interface requires knowledge of the special MDIO protocol to avoid possible internal signal contention or miscommunication to/from the PHY |

## 3.6 SPI EEPROM and FLASH Signals

| Symbol  | Type | Name and Function                                                                                                                                      |
|---------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| EE_DI   | TS   | EEPROM Data Input<br>The EEPROM Data Input pin is used for output to the SPI EEPROM memory device.                                                     |
| EE_DO   | I    | EEPROM Data Output<br>The EEPROM Data Output pin is used for input from the SPI EEPROM memory device. The EE_DO includes an internal pull-up resistor. |
| EE_CS_N | TS   | EEPROM Chip Select<br>The EEPROM Chip Select signal is used to enable the device.                                                                      |

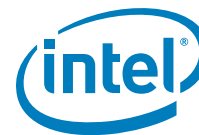


| Symbol    | Type | Name and Function                                                                                                                 |
|-----------|------|-----------------------------------------------------------------------------------------------------------------------------------|
| EE_SK     | TS   | EEPROM Serial Clock<br>The EEPROM Shift Clock provides the clock rate for the SPI EEPROM interface, which is approximately 2 MHz. |
| FLSH_CE_N | TS   | FLASH Chip Enable Output.<br>Used to enable FLASH device.                                                                         |
| FLSH_SCK  | TS   | FLASH Serial Clock Output.                                                                                                        |
| FLSH_SI   | TS   | FLASH Serial Data Input.<br>This pin is an output to the memory device.                                                           |
| FLSH_SO   | I    | FLASH Serial Data Output<br>This pin is an input from the memory device.                                                          |

## 3.7 LED Signals

**Note:** LED outputs are assumed to normally be connected to the negative side (cathode) of an external LED.

| Symbol | Type | Name and Function                                                                                                                                        |
|--------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| LED0_0 | O    | LED0_0. Programmable LED output for Port A. As the Link LED, it indicates link connectivity on Port A.                                                   |
| LED0_1 | O    | LED0_1. Programmable LED output for Port A. As the Activity LED, it flashes to indicate receive activity on Port A for packets destined for this node.   |
| LED0_2 | O    | LED0_2<br>Programmable LED output for Port A. As the Link 100 LED, it indicates link at 100 Mbps for Port A.                                             |
| LED0_3 | O    | LED0_3<br>Programmable LED output for Port A. As the Link 1000 LED, it indicates link at 1000 Mbps for Port A.                                           |
| LED1_0 | O    | LED1_0.<br>Programmable LED output for Port B. As the Link LED, it indicates link connectivity on Port B.                                                |
| LED1_1 | O    | LED1_1<br>Programmable LED output for Port B. As the Activity LED, it flashes to indicate receive activity on Port B for packets destined for this node. |
| LED1_2 | O    | LED1_2<br>Programmable LED output for Port B. As the Link 100 LED, it indicates link at 100 Mbps for Port B.                                             |
| LED1_3 | O    | LED1_3<br>Programmable LED output for Port B. As the Link 1000 LED, it indicates link at 1000 Mbps for Port B.                                           |



## 3.8 Other Signals

| Symbol                                                                       | Type | Name and Function                                                                                                                                                                                                                                                                         |
|------------------------------------------------------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SDP0_0<br>SDP0_1<br>SDP0_2<br>SDP0_3<br>SDP1_0<br>SDP1_1<br>SDP1_2<br>SDP1_3 | TS   | Software Defined Pin (SDP)<br><br>The Software Defined Pins are programmable with respect to input and output capability. These pins also can optionally be configured as interrupt inputs. SDP signals default to inputs upon power-up, but can be configured differently by the EEPROM. |

## 3.9 Crystal Signals

| Symbol | Type | Name and Function                                                                                                                                                                                                                 |
|--------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| XTAL1  | AI   | Crystal One<br><br>The Crystal One pin is a 25 MHz input signal. It should be connected to a parallel resonant crystal with a frequency tolerance of 30 ppm or better. The other end of the crystal should be connected to XTAL2. |
| XTAL2  | AO   | Crystal Two<br><br>Crystal Two is the output of an internal oscillator circuit used to drive a crystal into oscillation.                                                                                                          |

## 3.10 PHY Analog Signals

| Symbol                                       | Type | Name and Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------------------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RBIAS0_P/RBIAS1_P                            | A    | <b>Compensation Reference Resistor.</b><br>A 1.4 K $\Omega$ , 1% tolerance resistor should be used. RBIAS_N should also be connected to ground (VSS).                                                                                                                                                                                                                                                                                                                                                                |
| MDI0_P_0<br>MDI0_N_0<br>MDI1_P_0<br>MDI1_N_0 | A    | Media Dependent Interface [0]<br><br><b>1000BASE-T:</b> In MDI configuration, these correspond to BI_DA+/-, and in MDI-X configuration, MDIp0/MDIn0 corresponds to BI_DB+/-.<br><br><b>100BASE-TX:</b> In MDI configuration, MDIp0/MDIn0 is used for the transmit pair, and in MDI-X configuration, MDIp0/MDIn0 is used for the receive pair.<br><br><b>10BASE-T:</b> In MDI configuration, MDIAp0/MDI_MINUS0_0 is used for the transmit pair, and in MDI-X configuration, MDIp0/MDIn0 is used for the receive pair. |
| MDI0_P_1<br>MDI0_N_1<br>MDI1_P_1<br>MDI1_N_1 | A    | Media Dependent Interface [1]<br><br><b>1000BASE-T:</b> In MDI configuration, MDIp1/MDIn1 corresponds to BI_DB+/-, and in MDI-X configuration, MDIp1/MDIn1 corresponds to BI_DA+/-.<br><br><b>100BASE-TX:</b> In MDI configuration, MDIp1/MDIn1 is used for the receive pair, and in MDI-X configuration, MDIp1/MDIn1 is used for the transmit pair.<br><br><b>10BASE-T:</b> In MDI configuration, MDIp1/MDIn1 is used for the receive pair, and in MDI-X configuration, MDIp1/MDIn1 is used for the transmit pair.  |



| Symbol                                       | Type | Name and Function                                                                                                                                                                                                                                        |
|----------------------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MDI0_P_2<br>MDI0_N_2<br>MDI1_P_2<br>MDI1_N_2 | A    | Media Dependent Interface [2]<br><br><b>1000BASE-T</b> : In MDI configuration, MDIp2/MDIn2 corresponds to BI_DC+/-, and in MDI-X configuration, MDIp2/MDIn2 corresponds to BI_DD+/-.<br><br><b>100BASE-TX</b> : Unused.<br><br><b>10BASE-T</b> : Unused. |
| MDI0_P_3<br>MDI0_N_3<br>MDI1_P_3<br>MDI1_N_3 | A    | Media Dependent Interface [3]<br><br><b>1000BASE-T</b> : In MDI configuration, MDIp3/MDIn3 corresponds to BI_DD+/-, and in MDI-X configuration, MDIp3/MDIn3 corresponds to BI_DC+/-.<br><br><b>100BASE-TX</b> : Unused.<br><br><b>10BASE-T</b> : Unused. |

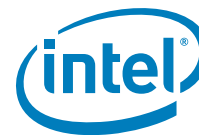
## 3.11 Serializer / Deserializer Signals

| Symbol                                           | Type      | Name and Function                                                                                                                                                                                                                                                                                                                                                                |
|--------------------------------------------------|-----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SRDSI_0_P<br>SRDSI_0_N<br>SRDSI_1_P<br>SRDSI_1_N | AI        | SERDES Receive Pairs A and B<br><br>These signals make the differential receive pair for the 1.25 GHz serial interface. For serializer/deserializer operation, the inputs should be coupled to ECL voltage levels. If the SERDES interface is not used, these pins should not be connected.                                                                                      |
| SRDSO_0_P<br>SRDSO_0_N<br>SRDSO_1_P<br>SRDSO_1_N | AO        | SERDES Transmit Pairs A and B<br><br>These signals make the differential transmit pair for the 1.25 GHz serial interface. For serializer/deserializer operation, the outputs drive the LVPECL voltage levels. If the SERDES interface is not used, these pins should not be connected.                                                                                           |
| SRDS0_SIG_DET/<br>SRDS1_SIG_DET                  | I         | Signal Detects A and B<br><br>These pins indicate whether the SERDES signals (connected to the 1.25 GHz serial interface) have been detected by the optical transceivers. If the SERDES interface is not used with copper media, these can be left with no connection (NC). If the SERDES interface is not used with fiber media, the SIG_DET inputs should be tied high to VCC. |
| SER_RCOMP                                        | A         | SERDES Impedance Compensation. Connect the recommended resistor (1.4K $\Omega$ ) from this ball to ground.                                                                                                                                                                                                                                                                       |
| SFP0_I2C_CLK                                     | O         | Port 0 SFP I2C clock. Connects to Mod-Def1 input of SFP. Can also be used as MDC pin.                                                                                                                                                                                                                                                                                            |
| SFP0_I2C_DATA                                    | TS/<br>OD | Port 0 SFP I2C data. Connects to Mod-Def2 pin of SFP. Can also be used as MDIO pin                                                                                                                                                                                                                                                                                               |
| SFP1_I2C_CLK                                     | O         | Port 1 SFP I2C clock. Connects to Mod-Def1 input of SFP. Can also be used as MDC pin.                                                                                                                                                                                                                                                                                            |
| SFP1_I2C_DATA                                    | TS/<br>OD | Port 1 SFP I2C data. Connects to Mod-Def2 pin of SFP. Can also be used as MDIO pin                                                                                                                                                                                                                                                                                               |

## 3.12 Test Interface Signals

**Note:** Pull-up resistors are needed on these signals as shown in the reference schematic.

| Symbol | Type | Name and Function                  |
|--------|------|------------------------------------|
| JTCK   | I    | JTAG Test Access Port Clock        |
| JTDI   | I    | JTAG Test Access Port Test Data In |



| Symbol | Type | Name and Function                   |
|--------|------|-------------------------------------|
| JTDO   | OD   | JTAG Test Access Port Test Data Out |
| JTMS   | I    | JTAG Test Access Port Mode Select   |

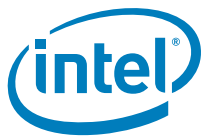
## 3.13 Power Supply Connections

### 3.13.1 Digital and Analog Supplies

| Symbol | Type | Name and Function                                                                                                                                        |
|--------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------|
| VCC3P3 | P    | 3.3 V Digital Power Supply.<br>For I/O circuits.                                                                                                         |
| VCC1P8 | P    | 1.8 V Analog Power Supply<br>For PHY analog, PHY I/O, PCI Express analog, and Phase Lock Loop circuits, Connect all 1.8 V pins to a single power supply. |
| VCC1P0 | P    | 1.0 V Digital Power Supply<br>For core digital, PHY digital, PCI Express digital and clock circuits, connect all 1.0 V pins to a single power supply.    |

### 3.13.2 Grounds, Reserved Pins and No Connects

| Symbol   | Type | Name and Function                                                                                                                                                                                              |
|----------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VSS      | P    | Ground.                                                                                                                                                                                                        |
| RSVD_VCC |      | Reserved, VCC<br>These pins are reserved by Intel and may have factory test functions. For normal operation, connect them directly to VCC. Do not connect them to pull-up resistors.                           |
| RSVD_GND | P    | Reserved, Ground<br>These pins are reserved by Intel and may have factory test functions. For normal operation, connect them directly to ground. Do not connect them to pull-down resistors.                   |
| RSVD_NC  | P    | Reserved, No Connect<br>These pins are reserved by Intel and may have factory test functions. For normal operation, do not connect any circuitry to these pins. Do not connect pull-up or pull-down resistors. |
| NC       | P    | No Connect<br>This pin is not connected internally.                                                                                                                                                            |



## 4.0 Pinout/Signal Name

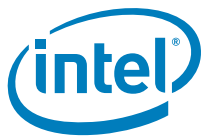
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The pinout table follows.

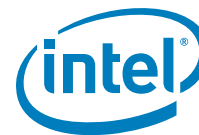
| Name      | Pin  |
|-----------|------|
| PE_CLK_P  | N2   |
| PE_CLK_N  | N1   |
|           |      |
| PET_0_P   | D2   |
| PET_0_N   | D1   |
| PET_1_P   | H2   |
| PET_1_N   | H1   |
| PET_2_P   | R2   |
| PET_2_N   | R1   |
| PET_3_P   | W2   |
| PET_3_N   | W1   |
|           |      |
| PER_0_P   | F2   |
| PER_0_N   | F1   |
| PER_1_P   | K2   |
| PER_1_N   | K1   |
| PER_2_P   | U2   |
| PER_2_N   | U1   |
| PER_3_P   | AA2  |
| PER_3_N   | AA1  |
|           |      |
| PE_WAKE_N | AC20 |
|           |      |
| PE_RST_N  | AC9  |
|           |      |
| PE_RCOMP  | L1   |



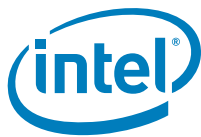
|              |      |
|--------------|------|
|              |      |
| RSVDM3_NC    | M3   |
| RSVDM2_NC    | M2   |
|              |      |
|              |      |
| FLSH_SI      | AC14 |
| FLSH_SO      | AD14 |
| FLSH_SCK     | AD15 |
| FLSH_CE_N    | AC15 |
|              |      |
|              |      |
| EE_DI        | A21  |
| EE_DO        | A20  |
| EE_SK        | B20  |
| EE_CS_N      | B21  |
|              |      |
|              |      |
| SMBD         | AD21 |
| SMBCLK       | AC21 |
| SMBALRT_N    | AD20 |
|              |      |
|              |      |
| FLBMD        | AD17 |
| FLBMCK       | AC17 |
| FLBSD        | AC16 |
| FLBSINTCKEX  | AD16 |
|              |      |
|              |      |
| NCSI_CLK_IN  | B5   |
| NCSI_CLK_OUT | B4   |
|              |      |
| NCSI_CRS_DV  | A4   |
| NCSI_RXD_1   | A6   |
| NCSI_RXD_0   | B7   |
|              |      |



|             |      |
|-------------|------|
| NCSI_TX_EN  | B6   |
| NCSI_TXD_1  | A7   |
| NCSI_TXD_0  | B8   |
|             |      |
|             |      |
| SDP0_0      | A16  |
| SDP0_1      | B16  |
| SDP0_2      | B17  |
| SDP0_3      | B15  |
|             |      |
| SDP1_0      | AD10 |
| SDP1_1      | A12  |
| SDP1_2      | A13  |
| SDP1_3      | AC10 |
|             |      |
| RSVDAB19_NC | AB19 |
| RSVDAB18_NC | AB18 |
|             |      |
| RSVDAD9_3P3 | AD9  |
|             |      |
| MAIN_PWR_OK | AD4  |
|             |      |
| DEV_OFF_N   | B9   |
|             |      |
| RSVDL14_1P0 | L14  |
| RSVDP14_1P0 | P14  |
|             |      |
| XTAL1       | N23  |
| XTAL2       | N24  |
|             |      |
| SRDSI_0_P   | J23  |
| SRDSI_0_N   | J24  |
| SRDSO_0_P   | K23  |
| SRDSO_0_N   | K24  |
|             |      |



|                     |      |
|---------------------|------|
| SRDS0_SIG_DET       | A9   |
|                     |      |
| SRDSI_1_P           | T23  |
| SRDSI_1_N           | T24  |
| SRDSO_1_P           | R23  |
| SRDSO_1_N           | R24  |
|                     |      |
| SRDS1_SIG_DET       | A10  |
|                     |      |
| SER_RCOMP           | L22  |
|                     |      |
| RSVDM23_NC          | M23  |
| RSVDM24_NC          | M24  |
|                     |      |
| SFP0_I2C_CLK/MDC0   | AD19 |
| SFP0_I2C_DATA/MDIO0 | AD18 |
|                     |      |
| SFP1_I2C_CLK/MDC1   | AC19 |
| SFP1_I2C_DATA/MDIO1 | AC18 |
|                     |      |
| LED0_0              | A19  |
| LED0_1              | B19  |
| LED0_2              | B18  |
| LED0_3              | A18  |
|                     |      |
| LED1_0              | AD13 |
| LED1_1              | AC11 |
| LED1_2              | AC13 |
| LED1_3              | AC12 |
|                     |      |
| MDIO_P_0            | C24  |
| MDIO_N_0            | C23  |
| MDIO_P_1            | D24  |
| MDIO_N_1            | D23  |
| MDIO_P_2            | F24  |



|              |      |
|--------------|------|
| MDI0_N_2     | F23  |
| MDI0_P_3     | G24  |
| MDI0_N_3     | G23  |
|              |      |
| RBIAS0_P     | E22  |
| VSS          | F22  |
|              |      |
| IEEE_TEST0_P | A22  |
| IEEE_TEST0_N | B22  |
|              |      |
| MDI1_P_0     | AB24 |
| MDI1_N_0     | AB23 |
| MDI1_P_1     | AA24 |
| MDI1_N_1     | AA23 |
| MDI1_P_2     | W24  |
| MDI1_N_2     | W23  |
| MDI1_P_3     | V24  |
| MDI1_N_3     | V23  |
|              |      |
| RBIAS1_P     | Y22  |
|              |      |
| IEEE_TEST1_P | AD22 |
| IEEE_TEST1_N | AC22 |
|              |      |
| RSVDAD8_VSS  | AD8  |
|              |      |
| JTCK         | AC6  |
| JTDI         | AD7  |
| JTDO         | AC8  |
| JTMS         | AC7  |
| RSVDAC5_3P3  | AC5  |
|              |      |
| AUX_PWR      | B14  |
| LAN1_DIS_N   | A15  |
| RSVDB12_3P3  | B12  |



|             |      |
|-------------|------|
| LAN0_DIS_N  | B13  |
| RSVDA8_3P3  | A8   |
| RSVDA11_3P3 | A11  |
| RSVDB10_3P3 | B10  |
| RSVDB11_3P3 | B11  |
| RSVDA14_VSS | A14  |
|             |      |
| NCB3        | B3   |
| NCAC3       | AC3  |
| NCAD3       | AD3  |
|             |      |
| VCC3P3      | AD6  |
| VCC3P3      | AD12 |
| VCC3P3      | A5   |
| VCC3P3      | A17  |
|             |      |
| VCC1P8      | P5   |
| VCC1P8      | P4   |
| VCC1P8      | N9   |
| VCC1P8      | N8   |
| VCC1P8      | N5   |
| VCC1P8      | N4   |
| VCC1P8      | M9   |
| VCC1P8      | M8   |
| VCC1P8      | M5   |
| VCC1P8      | M4   |
| VCC1P8      | L9   |
| VCC1P8      | L8   |
| VCC1P8      | L5   |
| VCC1P8      | L4   |
| VCC1P8      | L15  |
| VCC1P8      | K15  |
| VCC1P8      | J15  |
| VCC1P8      | H15  |
| VCC1P8      | G15  |



|        |      |
|--------|------|
| VCC1P8 | E20  |
| VCC1P8 | E19  |
| VCC1P8 | D20  |
| VCC1P8 | D19  |
| VCC1P8 | Y20  |
| VCC1P8 | Y19  |
| VCC1P8 | V15  |
| VCC1P8 | U15  |
| VCC1P8 | T15  |
| VCC1P8 | R15  |
| VCC1P8 | P15  |
| VCC1P8 | AA20 |
| VCC1P8 | AA19 |
| VCC1P8 | N21  |
| VCC1P8 | N15  |
| VCC1P8 | M21  |
| VCC1P8 | M15  |
| VCC1P8 | P9   |
| VCC1P8 | P8   |
|        |      |
| VCC1P0 | R14  |
| VCC1P0 | R13  |
| VCC1P0 | R12  |
| VCC1P0 | R11  |
| VCC1P0 | P13  |
| VCC1P0 | P12  |
| VCC1P0 | L13  |
| VCC1P0 | L12  |
| VCC1P0 | K14  |
| VCC1P0 | K13  |
| VCC1P0 | K12  |
| VCC1P0 | K11  |
| VCC1P0 | V5   |
| VCC1P0 | V4   |
| VCC1P0 | U5   |



|        |     |
|--------|-----|
| VCC1P0 | U4  |
| VCC1P0 | P11 |
| VCC1P0 | N11 |
| VCC1P0 | M11 |
| VCC1P0 | L11 |
| VCC1P0 | H5  |
| VCC1P0 | H4  |
| VCC1P0 | G5  |
| VCC1P0 | G4  |
| VCC1P0 | J21 |
| VCC1P0 | J20 |
| VCC1P0 | J18 |
| VCC1P0 | J17 |
| VCC1P0 | L21 |
| VCC1P0 | L20 |
| VCC1P0 | L18 |
| VCC1P0 | L17 |
| VCC1P0 | K21 |
| VCC1P0 | K20 |
| VCC1P0 | K18 |
| VCC1P0 | K17 |
| VCC1P0 | T21 |
| VCC1P0 | T20 |
| VCC1P0 | T18 |
| VCC1P0 | T17 |
| VCC1P0 | P21 |
| VCC1P0 | P20 |
| VCC1P0 | P18 |
| VCC1P0 | P17 |
| VCC1P0 | R21 |
| VCC1P0 | R20 |
| VCC1P0 | R18 |
| VCC1P0 | R17 |
|        |     |
| VSS    | Y9  |



|     |     |
|-----|-----|
| VSS | Y8  |
| VSS | Y7  |
| VSS | Y6  |
| VSS | Y15 |
| VSS | Y14 |
| VSS | Y13 |
| VSS | Y12 |
| VSS | Y11 |
| VSS | Y10 |
| VSS | W9  |
| VSS | W8  |
| VSS | W7  |
| VSS | W22 |
| VSS | W14 |
| VSS | W13 |
| VSS | W12 |
| VSS | W11 |
| VSS | W10 |
| VSS | V9  |
| VSS | V8  |
| VSS | V14 |
| VSS | V13 |
| VSS | V12 |
| VSS | V11 |
| VSS | V10 |
| VSS | U9  |
| VSS | U14 |
| VSS | U13 |
| VSS | U12 |
| VSS | U11 |
| VSS | U10 |
| VSS | T14 |
| VSS | T13 |
| VSS | T12 |
| VSS | T11 |



|     |     |
|-----|-----|
| VSS | N14 |
| VSS | N13 |
| VSS | N12 |
| VSS | M14 |
| VSS | M13 |
| VSS | M12 |
| VSS | J14 |
| VSS | J13 |
| VSS | J12 |
| VSS | J11 |
| VSS | H9  |
| VSS | H14 |
| VSS | H13 |
| VSS | H12 |
| VSS | H11 |
| VSS | H10 |
| VSS | G9  |
| VSS | G8  |
| VSS | G14 |
| VSS | G13 |
| VSS | G12 |
| VSS | G11 |
| VSS | G10 |
| VSS | F9  |
| VSS | F8  |
| VSS | F7  |
| VSS | F14 |
| VSS | F13 |
| VSS | F12 |
| VSS | F11 |
| VSS | F10 |
| VSS | E9  |
| VSS | E8  |
| VSS | E7  |
| VSS | E6  |



|     |     |
|-----|-----|
| VSS | E15 |
| VSS | E14 |
| VSS | E13 |
| VSS | E12 |
| VSS | E11 |
| VSS | E10 |
| VSS | D9  |
| VSS | D8  |
| VSS | D7  |
| VSS | D6  |
| VSS | D5  |
| VSS | D16 |
| VSS | D15 |
| VSS | D14 |
| VSS | D13 |
| VSS | D12 |
| VSS | D11 |
| VSS | D10 |
| VSS | C9  |
| VSS | C8  |
| VSS | C7  |
| VSS | C6  |
| VSS | C5  |
| VSS | C4  |
| VSS | C17 |
| VSS | C16 |
| VSS | C15 |
| VSS | C14 |
| VSS | C13 |
| VSS | C12 |
| VSS | C11 |
| VSS | C10 |
| VSS | B2  |
| VSS | B1  |
| VSS | AD5 |



|     |      |
|-----|------|
| VSS | AD2  |
| VSS | AD11 |
| VSS | AD1  |
| VSS | AC4  |
| VSS | AC2  |
| VSS | AC1  |
| VSS | AB9  |
| VSS | AB8  |
| VSS | AB7  |
| VSS | AB6  |
| VSS | AB5  |
| VSS | AB4  |
| VSS | AB17 |
| VSS | AB16 |
| VSS | AB15 |
| VSS | AB14 |
| VSS | AB13 |
| VSS | AB12 |
| VSS | AB11 |
| VSS | AB10 |
| VSS | AA9  |
| VSS | AA8  |
| VSS | AA7  |
| VSS | AA6  |
| VSS | AA5  |
| VSS | AA16 |
| VSS | AA15 |
| VSS | AA14 |
| VSS | AA13 |
| VSS | AA12 |
| VSS | AA11 |
| VSS | AA10 |
| VSS | A3   |
| VSS | A2   |
| VSS | A1   |



|     |     |
|-----|-----|
| VSS | Y24 |
| VSS | Y23 |
| VSS | Y21 |
| VSS | Y18 |
| VSS | Y17 |
| VSS | Y16 |
| VSS | W21 |
| VSS | W20 |
| VSS | W19 |
| VSS | W18 |
| VSS | W17 |
| VSS | W16 |
| VSS | W15 |
| VSS | V22 |
| VSS | V21 |
| VSS | V20 |
| VSS | V19 |
| VSS | V18 |
| VSS | V17 |
| VSS | V16 |
| VSS | U24 |
| VSS | U23 |
| VSS | U22 |
| VSS | U21 |
| VSS | U20 |
| VSS | U19 |
| VSS | U18 |
| VSS | U17 |
| VSS | U16 |
| VSS | T22 |
| VSS | T19 |
| VSS | T16 |
| VSS | R22 |
| VSS | R19 |
| VSS | R16 |



|     |     |
|-----|-----|
| VSS | P24 |
| VSS | P23 |
| VSS | P22 |
| VSS | P19 |
| VSS | P16 |
| VSS | N22 |
| VSS | N20 |
| VSS | N19 |
| VSS | N18 |
| VSS | N17 |
| VSS | N16 |
| VSS | M22 |
| VSS | M20 |
| VSS | M19 |
| VSS | M18 |
| VSS | M17 |
| VSS | M16 |
| VSS | L24 |
| VSS | L23 |
| VSS | L19 |
| VSS | L16 |
| VSS | K22 |
| VSS | K19 |
| VSS | K16 |
| VSS | J22 |
| VSS | J19 |
| VSS | J16 |
| VSS | H24 |
| VSS | H23 |
| VSS | H22 |
| VSS | H21 |
| VSS | H20 |
| VSS | H19 |
| VSS | H18 |
| VSS | H17 |



|     |      |
|-----|------|
| VSS | H16  |
| VSS | G22  |
| VSS | G21  |
| VSS | G20  |
| VSS | G19  |
| VSS | G18  |
| VSS | G17  |
| VSS | G16  |
| VSS | F21  |
| VSS | F20  |
| VSS | F19  |
| VSS | F18  |
| VSS | F17  |
| VSS | F16  |
| VSS | F15  |
| VSS | E24  |
| VSS | E23  |
| VSS | E21  |
| VSS | E18  |
| VSS | E17  |
| VSS | E16  |
| VSS | D22  |
| VSS | D21  |
| VSS | D18  |
| VSS | D17  |
| VSS | C22  |
| VSS | C21  |
| VSS | C20  |
| VSS | C19  |
| VSS | C18  |
| VSS | B24  |
| VSS | B23  |
| VSS | AD24 |
| VSS | AD23 |
| VSS | AC24 |



|     |      |
|-----|------|
| VSS | AC23 |
| VSS | AB22 |
| VSS | AB21 |
| VSS | AB20 |
| VSS | AA22 |
| VSS | AA21 |
| VSS | AA18 |
| VSS | AA17 |
| VSS | A24  |
| VSS | A23  |
| VSS | Y5   |
| VSS | Y4   |
| VSS | Y3   |
| VSS | Y2   |
| VSS | Y1   |
| VSS | W6   |
| VSS | W5   |
| VSS | W4   |
| VSS | W3   |
| VSS | V7   |
| VSS | V6   |
| VSS | V3   |
| VSS | V2   |
| VSS | V1   |
| VSS | U8   |
| VSS | U7   |
| VSS | U6   |
| VSS | U3   |
| VSS | T9   |
| VSS | T8   |
| VSS | T7   |
| VSS | T6   |
| VSS | T5   |
| VSS | T4   |
| VSS | T3   |



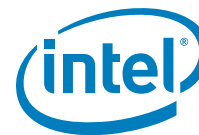
|     |     |
|-----|-----|
| VSS | T2  |
| VSS | T10 |
| VSS | T1  |
| VSS | R9  |
| VSS | R8  |
| VSS | R7  |
| VSS | R6  |
| VSS | R5  |
| VSS | R4  |
| VSS | R3  |
| VSS | R10 |
| VSS | P7  |
| VSS | P6  |
| VSS | P3  |
| VSS | P2  |
| VSS | P10 |
| VSS | P1  |
| VSS | N7  |
| VSS | N6  |
| VSS | N3  |
| VSS | N10 |
| VSS | M7  |
| VSS | M6  |
| VSS | M10 |
| VSS | M1  |
| VSS | L7  |
| VSS | L6  |
| VSS | L3  |
| VSS | L2  |
| VSS | L10 |
| VSS | K9  |
| VSS | K8  |
| VSS | K7  |
| VSS | K6  |
| VSS | K5  |



|     |     |
|-----|-----|
| VSS | K4  |
| VSS | K3  |
| VSS | K10 |
| VSS | J9  |
| VSS | J8  |
| VSS | J7  |
| VSS | J6  |
| VSS | J5  |
| VSS | J4  |
| VSS | J3  |
| VSS | J2  |
| VSS | J10 |
| VSS | J1  |
| VSS | H8  |
| VSS | H7  |
| VSS | H6  |
| VSS | H3  |
| VSS | G7  |
| VSS | G6  |
| VSS | G3  |
| VSS | G2  |
| VSS | G1  |
| VSS | F6  |
| VSS | F5  |
| VSS | F4  |
| VSS | F3  |
| VSS | E5  |
| VSS | E4  |
| VSS | E3  |
| VSS | E2  |
| VSS | E1  |
| VSS | D4  |
| VSS | D3  |
| VSS | C3  |
| VSS | C2  |



|     |     |
|-----|-----|
| VSS | C1  |
| VSS | AB3 |
| VSS | AB2 |
| VSS | AB1 |
| VSS | AA4 |
| VSS | AA3 |



## 5.0 Power Requirements

### 5.1 Targeted Absolute Maximum Ratings

**Table 1. Absolute Maximum Ratings<sup>1</sup>**

| Symbol                          | Parameter                                                                                         | Min                                 | Max                                   | Unit |
|---------------------------------|---------------------------------------------------------------------------------------------------|-------------------------------------|---------------------------------------|------|
| VCC(3.3)                        | DC supply voltage on 3.3 V pins with respect to VSS                                               | VSS - 0.5                           | 4.6                                   | V    |
| VCC(1.8)                        | DC supply voltage on 1.8 V pins with respect to VSS <sup>2</sup>                                  | VSS - 0.3                           | 2.5                                   | V    |
| VCC(1.0)                        | DC supply voltage on 1.0 V pins with respect to VSS <sup>b</sup>                                  | VSS - 0.2                           | 1.7                                   | V    |
| V <sub>I</sub> / V <sub>O</sub> | 3.3 V I/O Voltage<br>1.8 V I/O Voltage<br>1.0 V I/O Voltage                                       | VSS - 0.5<br>VSS - 0.3<br>VSS - 0.2 | 4.6<br>2.5<br>1.7                     | V    |
| I <sub>O</sub>                  | DC output current                                                                                 | N/A                                 | TBD                                   | mA   |
| T <sub>storage</sub>            | Storage temperature range                                                                         | -65                                 | 140                                   | °C   |
| T <sub>case</sub>               | Case temperature under bias                                                                       | 0                                   | 85                                    | °C   |
|                                 | ESD per MIL_STD-883 Test Method 3015, Specification 2001V Latchup Over/Undershoot: 150 mA, 125° C | N/A                                 | VDD overstress:<br>VDD(3.3) * (7.2 V) | V    |

1. Maximum ratings are referenced to ground (VSS). Permanent device damage is likely to occur if the ratings in this table are exceeded for an indefinite duration. These values should not be used as the limits for normal device operations.
2. During normal device power up and power down, the 1.8 V and 1.0 V supplies must not ramp before the 3.3 V supply.



## 5.2 Targeted Recommended Operating Conditions

### 5.2.1 General Operating Conditions

**Table 2. Recommended Operating Conditions <sup>1</sup>**

| Symbol         | Parameter                             | Min  | Max  | Unit |
|----------------|---------------------------------------|------|------|------|
| VCC(3.3)       | DC supply voltage on 3.3 V pins       | 3.0  | 3.6  | V    |
| VCC(1.8)       | DC supply voltage on 1.8 V pins       | 1.71 | 1.89 | V    |
| VCC(1.0)       | DC supply voltage on 1.0 V pins       | 0.95 | 1.05 | V    |
| tR / tF        | Input rise/fall time (normal input)   | 0    | 200  | ns   |
| T <sub>a</sub> | Operating temperature range (ambient) | 0    | 55   | °C   |
| T <sub>j</sub> | Junction temperature                  | N/A  | ≤110 | °C   |

1. Sustained operation of the device at conditions exceeding these values, even if they are within the absolute maximum rating limits, might result in permanent damage. Device functionality to stated DC and AC limits is not guaranteed, if conditions exceed recommended operating conditions.

### 5.2.2 Voltage Ramp and Sequencing Recommendations

The following tables give the specifications for the power supply ramps:

**Table 3. 3.3 V Supply Voltage Ramp**

| Parameter         | Description                                           | Min | Max              | Unit                    |
|-------------------|-------------------------------------------------------|-----|------------------|-------------------------|
| Rise Time         | Time from 10% to 90% mark                             | 0.1 | 100 <sup>1</sup> | ms                      |
| Monotonicity      | Voltage dip allowed in ramp                           | N/A | 0                | mV                      |
| Slope             | Ramp rate at any time between 10% to 90%              | 24  | 28800            | mV/ms                   |
| Operational Range | Voltage range for normal operating conditions         | 3   | 3.6              | V                       |
| Ripple            | Maximum voltage ripple at a bandwidth equal to 50 MHz | N/A | 70               | mV <sub>peak-peak</sub> |
| Ripple            | Overshoot time upon ramp <sup>2</sup>                 | N/A | 0.05             | ms                      |
| Overshoot         | Maximum voltage allowed <sup>b</sup>                  | N/A | 100              | mV                      |

1. Good design practices achieve voltage ramps to within the regulation bands in approximately 20 ms or less.  
2. Excessive overshoot can affect long term reliability.

**Table 4. 1.8 V Supply Voltage Ramp**

| Parameter              | Description                                          | Min  | Max              | Unit                    |
|------------------------|------------------------------------------------------|------|------------------|-------------------------|
| Rise Time              | Time from 10% to 90% mark                            | 0.1  | 100 <sup>1</sup> | ms                      |
| Monotonicity           | Voltage dip allowed in ramp                          | N/A  | 0                | mV                      |
| Slope                  | Ramp rate at any time between 10% to 90%             | 14   | 60000            | mV/ms                   |
| Operational Range      | Voltage range for normal operating conditions        | 1.71 | 1.89             | V                       |
| Ripple                 | Maximum voltage ripple at a bandwidth equal to 1 MHz | N/A  | 40               | mV <sub>peak-peak</sub> |
| Overshoot SettlingTime | Overshoot time upon ramp <sup>2</sup>                | N/A  | 0.1              | ms                      |
| Overshoot              | Maximum voltage allowed <sup>b</sup>                 | N/A  | 100              | mV                      |

1. Good design practices achieve voltage ramps to within the regulation bands in approximately 20 ms or less.

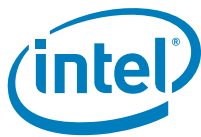
2. Excessive overshoot can affect long term reliability.

**Table 5. 1.0 V Supply Voltage Ramp**

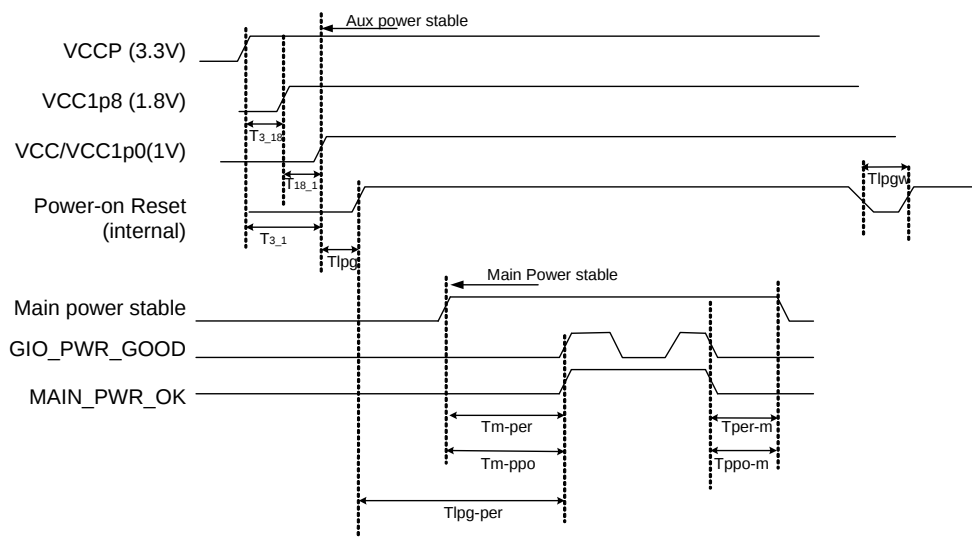
| Parameter              | Description                                          | Min  | Max              | Unit                    |
|------------------------|------------------------------------------------------|------|------------------|-------------------------|
| Rise Time              | Time from 10% to 90% mark                            | 0.1  | 100 <sup>1</sup> | ms                      |
| Monotonicity           | Voltage dip allowed in ramp                          | N/A  | 0                | mV                      |
| Slope                  | Ramp rate at any time between 10% to 90%             | 7.6  | 33600            | mV/ms                   |
| Operational Range      | Voltage range for normal operating conditions        | 0.95 | 1.05             | V                       |
| Ripple                 | Maximum voltage ripple at a bandwidth equal to 1 MHz | N/A  | 40               | mV <sub>peak-peak</sub> |
| Overshoot SettlingTime | Overshoot time upon ramp <sup>2</sup>                | N/A  | 0.05             | ms                      |
| Overshoot              | Maximum voltage allowed <sup>b</sup>                 | N/A  | 100              | mV                      |

1. Good design practices achieve voltage ramps to within the regulation bands in approximately 20 ms or less.

2. Excessive overshoot can affect long term reliability.


**Table 6. Power Supply Sequencing**

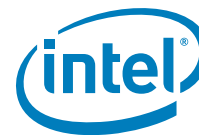
| Symbol                 | Parameter                                            | Min | Max | Unit |
|------------------------|------------------------------------------------------|-----|-----|------|
| $T_{3\ 18}$            | VCC3p3 (3.3 V) stable to VCC1p8 stable               | 0   | 100 | ms   |
| $T_{18\ 1}$            | VCC1p8 stable to VCC (1.0 V) stable                  | 0   |     | ms   |
| $T_{3\ 1}$             | VCC3p3 (3.3 V) stable to VCC (1.0 V) stable          | 0   | 100 | mV   |
| $T_{m-per}, T_{m-ppo}$ | 3.3 V core to GIO_PWR_GOOD and MAIN_PWR_OK on        | TBD |     | ms   |
| $T_{per-m}, T_{ppo-m}$ | GIO_PWR_GOOD, MAIN_PWR_OK off before 3.3 V core down | 0   |     | ms   |


**Figure 2. Voltage Power Sequencing Options**

To meet the 375 mA inrush current requirements (not including external capacitors) the ramp time should be 5 ms -100 ms on all power rails. For faster ramps (100 us - 5 ms), expect higher inrush current due to the high charging current of the decoupling capacitors of 3.3 V, 1.8 V and 1.0 V rails.

## 5.3 Thermal Information

The 82575EB device is specified for operation when the ambient temperature (TA) is within the range of 0 °C to 55 °C. For information about the thermal characteristics of the device, including operation outside this range, please refer to the 82575EB Thermal Application Note.



## 6.0 Electrical Specification

### 6.1 DC Specifications

**Table 7. DC Characteristics**

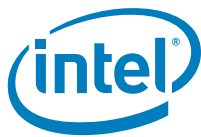
| Symbol   | Parameter                       | Condition | Min         | Typ         | Max         | Units |
|----------|---------------------------------|-----------|-------------|-------------|-------------|-------|
| VCC(3.3) | DC supply voltage on 3.3 V pins |           | 3.00        | 3.30        | 3.60        | V     |
| VCC(1.8) | DC supply voltage on 1.8 V pins |           | 1.71        | 1.80        | 1.89        | V     |
| VCC(1.0) | DC supply voltage on 1.0 V pins |           | <b>0.95</b> | <b>1.00</b> | <b>1.08</b> | V     |

**Table 8. I/O Characteristics**

| Symbol                       | Parameter                        | Condition <sup>1</sup>                              | Min                    | Typ | Max            | Units |
|------------------------------|----------------------------------|-----------------------------------------------------|------------------------|-----|----------------|-------|
| V <sub>IH</sub>              | Input high voltage               |                                                     | 2.0                    | N/A | VCC(3.3) + 0.5 | V     |
| V <sub>IL</sub>              | Input low voltage                |                                                     | -0.5                   | N/A | 0.8            | V     |
| I <sub>IN</sub>              | Input current                    | V <sub>IN</sub> = VDD(3.3) or V <sub>SS</sub>       | -15                    | N/A | 15             | μA    |
| V <sub>OH</sub>              | Output high voltage              | I <sub>OH</sub> = -16 mA<br>V <sub>CC</sub> = Min   | 2.4                    | N/A | N/A            | V     |
|                              |                                  | I <sub>OH</sub> = -100 μA<br>V <sub>CC</sub> = Min  | V <sub>CC</sub> - 0.02 | N/A | N/A            |       |
| V <sub>OL</sub>              | Output low voltage               | I <sub>OL</sub> = 14 mA<br>V <sub>CC</sub> = Min    | N/A                    | N/A | 0.4            | V     |
|                              |                                  | I <sub>OL</sub> = 100 μA<br>V <sub>CC</sub> = Min   | N/A                    | N/A | 0.2            |       |
| I <sub>OZ</sub>              | Off-state output leakage current | V <sub>O</sub> = V <sub>CC</sub> or V <sub>SS</sub> | -10                    | N/A | 10             | μA    |
| C <sub>IN</sub> <sup>2</sup> | Input capacitance                |                                                     | N/A                    | 2.5 | N/A            | pF    |
| PU                           | Internal pull-up                 |                                                     | 2.6                    | N/A | 5.5            | kΩ    |
| V <sub>OS</sub>              | Overshoot                        |                                                     | N/A                    | N/A | 4.0            | V     |
| V <sub>US</sub>              | Undershoot                       |                                                     | N/A                    | N/A | -0.4           | V     |

1. The input buffer also has hysteresis > 160 mV.

2. C<sub>in</sub> = 2.5 pF(maximum input capacitance), C<sub>out</sub> = 16 pF (characterized max output load capacitance per 160 MHz).

**Table 9. Open Drain I/O**

| Symbol   | Parameter              | Condition              | Min | Max   | Units | Note |
|----------|------------------------|------------------------|-----|-------|-------|------|
| VCC3P3   | Periphery supply       |                        | 3.0 | 3.6   | V     |      |
| VCC      | Core supply            |                        | 0.9 | 1.32  | V     |      |
| Vih      | Input High Voltage     |                        | 2.1 |       | V     |      |
| Vil      | Input Low Voltage      |                        |     | 0.8   | V     |      |
| Ileakage | Output Leakage Current | $0 < V_{in} < VCC3P3$  |     | +/-10 | µA    | 2    |
| Vol      | Output Low Voltage     | @ Ipullup              |     | 0.4   | V     | 4    |
| Ipullup  | Current sinking        | Vol=0.4V               | 4   |       | mA    |      |
| Cin      | Input Pin Capacitance  |                        |     | 7     | pF    | 3    |
| Cout     | Output Pin Capacitance |                        |     | 30    | pF    | 3    |
| Ioffsmb  | Input leakage current  | VCC3P3 off or floating |     | +/-10 | µA    | 2    |

**Notes:**

1. Applies to SMBD0, SMBCLK0, , SMBALRT\_N, PE\_WAKE\_n, SFP1\_I2C\_Data, SFP0\_I2C\_Data pads.
2. Device meets this whether powered or not.
3. Characterized, not tested.
4. OD no high output drive. VOL max=0.4V at 14mA, VOL max=0.2V at 0.1mA

**Table 10. Power Consumption**

|                           | D0a--Active Link          |                           |                           |                           |                           |                           |
|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|---------------------------|
|                           | @10 Mbps                  | @100 Mbps                 | @ 1000 Mbps (copper)      |                           | @ 1000 Mbps (SERDES)      |                           |
|                           | Typ Icc (mA) <sup>1</sup> | Typ Icc (mA) <sup>1</sup> | Typ Icc (mA) <sup>1</sup> | Max Icc (mA) <sup>1</sup> | Typ Icc (mA) <sup>1</sup> | Max Icc (mA) <sup>2</sup> |
| <b>3.3 V</b>              | 18                        | 18                        | 18                        | 23                        | 19                        | 19                        |
| <b>1.8 V</b>              | 344                       | 312                       | 841                       | 856                       | 142                       | 203                       |
| <b>1.0 V</b>              | 304                       | 388                       | 856                       | 1184                      | 354                       | 492                       |
| <b>Total Device Power</b> | 0.98 W                    | 1.01 W                    | 2.43 W                    | 2.80 W                    | 0.67 W                    | 0.92 W                    |

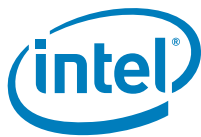
1. Typical conditions: operating temperature ( $T_A$ ) = 25 C, nominal voltages and moderate network traffic at full duplex.
2. Maximum conditions: maximum operating temperature ( $T_J$ ) values, typical voltage values and continuous network traffic at full duplex.

|                                       | D0a--Idle Link<br>Unplugged--no link<br>LOs only<br>Typ Icc (mA) <sup>1</sup> |
|---------------------------------------|-------------------------------------------------------------------------------|
| <b>3.3 V</b>                          | 18                                                                            |
| <b>1.8 V</b>                          | 129                                                                           |
| <b>1.0 V</b>                          | 264                                                                           |
| <b>Total Device Power<sup>2</sup></b> | 0.56                                                                          |

1. Typical conditions: room temperature ( $T_A$ )=25C, nominal voltages and idle network (no traffic) at full duplex
2. Known errata on LOs & L1 states might impact device power consumption

|                                       | D0a--Idle Link<br>@10Mbps<br>LOs only<br>Typ Icc (mA) <sup>1</sup> |
|---------------------------------------|--------------------------------------------------------------------|
| <b>3.3 V</b>                          | 18                                                                 |
| <b>1.8 V</b>                          | 140                                                                |
| <b>1.0 V</b>                          | 302                                                                |
| <b>Total Device Power<sup>2</sup></b> | 0.61 W                                                             |

1. Typical conditions: room temperature ( $T_A$ )=25C, nominal voltages and idle network (no traffic) at full duplex
2. Known errata on LOs & L1 states might impact device power consumption



|                                 | D0a--Idle Link<br>@100Mbps (Copper)<br>LOs only<br>Typ Icc (mA) <sup>1</sup> |
|---------------------------------|------------------------------------------------------------------------------|
| 3.3 V                           | 18                                                                           |
| 1.8 V                           | 837                                                                          |
| 1.0 V                           | 755                                                                          |
| Total Device Power <sup>2</sup> | 2.32 W                                                                       |

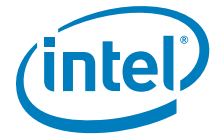
1. Typical conditions: room temperature (TA)=25C, nominal voltages and idle network (no traffic) at full duplex
2. Known errata on LOs & L1 states might impact device power consumption

|                                 | D0a--Idle Link<br>@1000Mbps (SERDES)<br>Typ Icc (mA) <sup>1</sup> |
|---------------------------------|-------------------------------------------------------------------|
| 3.3 V                           | 17                                                                |
| 1.8 V                           | 142                                                               |
| 1.0 V                           | 341                                                               |
| Total Device Power <sup>2</sup> | 0.65 W                                                            |

1. Typical conditions: room temperature (TA)=25C, nominal voltages and idle network (no traffic) at full duplex
2. Known errata on LOs & L1 states might impact device power consumption

|                    | D3cold - wake-up enabled |              | D3cold-wake disabled |
|--------------------|--------------------------|--------------|----------------------|
|                    | @10 Mbps                 | @100 Mbps    |                      |
|                    | Typ Icc (mA)             | Typ Icc (mA) |                      |
| 3.3 V              | 18                       | 18           | 18                   |
| 1.8 V              | 98                       | 269          | 83                   |
| 1.0 V              | 168                      | 249          | 70                   |
| Total Device Power | 0.40 W                   | 0.79 W       | 0.29 W               |

|                    | D(r) Uninitialized                         |
|--------------------|--------------------------------------------|
|                    | Disabled through DEV_OFF_N<br>Typ Icc (mA) |
| 3.3 V              | 11                                         |
| 1.8 V              | 179                                        |
| 1.0 V              | 283                                        |
| Total Device Power | 0.64                                       |



## 6.2 Resets

**Power-on Reset (internal):** The 82575EB has an internal mechanism for sensing the power pins. Once the power is up and stable, it creates an internal reset, this reset acts as a master reset of the entire chip. It is level sensitive, and while it is 0, will hold all of the registers in reset. Power-on Reset is interpreted to be an indication that device power supplies are all stable. Power-on Reset changes state during system power-up.

**In-band PCIe Reset:** The 82575EB will generate an internal reset in response to a physical layer message from the PCIe or when the PCIe link halts (entry to Polling or Detect state). This reset is equivalent to PCI reset in previous (PCI) gigabit LAN controllers.

**Main\_Power\_Good:** Used by the device to detect the D3Cold condition and activate part of the power saving scheme.



## 6.3 Pull-up and Pull-down Specifications and Signals

Table 11. Internal and External Pull-up and Pull-down Values

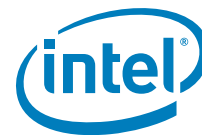
|                            | Min  | Nominal    | Max  | Units    |
|----------------------------|------|------------|------|----------|
| PU (Internal)              | 2.7K | 5K         | 8.6K | $\Omega$ |
| PU (External, recommended) |      | $\leq 3K$  |      | $\Omega$ |
| PD (External, recommended) |      | $\leq 400$ |      | $\Omega$ |

For external Pull-up requirements, see the 82575EB reference schematics.

The table below lists internal & external pull-up resistors and whether they are activated in the different device states. Each internal PUP has a nominal value of  $5k\Omega$ , ranging from  $2.7k\Omega$  to  $8.6k\Omega$ .

The device states are defined as follow:

- Power-up = while 3.3 V is stable, but not 1.0 V
- Active = normal mode (not power up nor disable)
- Disable = device disabled

**Table 12. Internal Pull-up and External Pull Up Requirements**

| Signal Name    | Power up | Active | Disable | External Recommended?        | Notes                                                                 |
|----------------|----------|--------|---------|------------------------------|-----------------------------------------------------------------------|
| PE_WAKE_N      | N        | N      | N       | Y                            |                                                                       |
| PE_RST_N       | Y        | N      | N       | N                            |                                                                       |
| FLSH_SI        | Y        | N      | Y       | N                            |                                                                       |
| FLSH_SO        | Y        | Y      | Y       | N                            |                                                                       |
| FLSH_SCK       | Y        | N      | Y       | N                            |                                                                       |
| FLSH_CE_N      | Y        | N      | Y       | Y                            |                                                                       |
| EE_DI          | Y        | N      | Y       | N                            |                                                                       |
| EE_DO          | Y        | Y      | Y       | N                            |                                                                       |
| EE_SK          | Y        | N      | Y       | N                            |                                                                       |
| EE_CS_N        | Y        | N      | Y       | Y                            |                                                                       |
| SMBD           | N        | N      | N       | Y                            |                                                                       |
| SMBCLK         | N        | N      | N       | Y                            |                                                                       |
| SMBALRT_N      | N        | N      | N       | Y                            |                                                                       |
| NCSI_CLK_IN    | N        | N      | N       | N                            |                                                                       |
| NCSI_CLK_OUT   | Y        | N      | N       | N                            |                                                                       |
| NCSI_CRS_DV    | N        | N      | N       | Y                            | Pull down only if NCSI is NOT being used or configured for multi drop |
| NCSI_RXD[1:0]  | N        | N      | N       | Y                            | Pull Up only if NCSI is NOT being used or configured for multi drop   |
| NCSI_TX_EN     | N        | N      | N       | N                            | Should be connected to external PD if NCSI is NOT used                |
| NCSI_TXD[1:0]  | N        | N      | N       | N                            | Should be connected to external PD if NCSI is NOT used                |
| SDP0[3:0]      | Y        | Y      | N       | N                            |                                                                       |
| SDP1[3:0]      | Y        | Y      | N       | N                            |                                                                       |
| DEV_OFF_N      | Y        | N      | N       | Must be connected on board   |                                                                       |
| MAIN_PWR_OK    | Y        | N      | N       | Must be connected on board   |                                                                       |
| SRDS_0_SIG_DET | Y        | N      | N       | Must be connected externally |                                                                       |
| SRDS_1_SIG_DET | Y        | N      | N       | Must be connected externally |                                                                       |
| SFP0_I2C_CLK   | Y        | N      | Y       | Y if active                  | If used.                                                              |
| SFP0_I2C_DATA  | Y        | N      | N       | Y                            | If used.                                                              |
| SFP1_I2C_CLK   | Y        | N      | Y       | Y if active                  | If used.                                                              |



|               |   |   |   |           |          |
|---------------|---|---|---|-----------|----------|
| SFP1_I2C_DATA | Y | N | N | Y         | If used. |
| LED0_0        | Y | N | N |           |          |
| LED0_1        | Y | N | N |           |          |
| LED0_2        | Y | N | N |           |          |
| LED0_3        | Y | N | N |           |          |
| LED1_0        | Y | N | N |           |          |
| LED1_1        | Y | N | N |           |          |
| LED1_2        | Y | N | N |           |          |
| LED1_3        | Y | N | N |           |          |
| JTCK          | Y | N | N | N         |          |
| JTDI          | Y | N | N | Y         |          |
| JTDO          | Y | N | N | Y         |          |
| JTMS          | Y | N | N | Y         |          |
| AUX_PWR       | Y | N | N | Y (or PD) |          |
| LAN1_DIS_N    | Y | Y | Y |           |          |
| LAN0_DIS_N    | Y | Y | Y |           |          |



## 6.4 Targeted AC Characteristics

**Table 13. 25 MHz Clock Input Requirements**

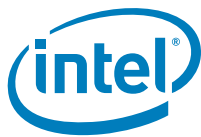
| Symbol           | Parameter                                | Min | Typ    | Max | Unit |
|------------------|------------------------------------------|-----|--------|-----|------|
| f <sub>0</sub>   | Frequency                                | N/A | 25.000 | N/A | MHz  |
| df <sub>0</sub>  | Frequency Variation                      | -50 | N/A    | +50 | ppm  |
| D <sub>c</sub>   | Duty Cycle                               | 40  | N/A    | 60  | %    |
| t <sub>r</sub>   | Rise Time                                | N/A | N/A    | 5   | ns   |
| t <sub>f</sub>   | Fall Time                                | N/A | N/A    | 5   | ns   |
| J <sub>ptp</sub> | Clock Jitter (peak-to-peak) <sup>1</sup> | N/A | N/A    | 250 | ps   |
| C <sub>in</sub>  | Input Capacitance                        | N/A | 20     | N/A | pF   |
| T                | Operating Temperature                    | N/A | N/A    | 70  | °C   |
| A <sub>ptp</sub> | Input clock amplitude (peak-to-peak)     | 1.0 | 1.2    | 1.3 | V    |
| V <sub>cm</sub>  | Clock common mode                        | N/A | 0.6    | N/A | V    |

1. Clock jitter is defined according to the recommendations of part 40.6.1.2.5 IEEE 1000Base-T Standard (at least 10<sup>5</sup> clock edges, filtered by HPF with cut off frequency of 5000 Hz).

**Table 14. Link Interface Clock Requirements**

| Symbol                        | Parameter         | Min | Typ | Max | Unit |
|-------------------------------|-------------------|-----|-----|-----|------|
| f <sub>GTX</sub> <sup>1</sup> | GTX_CLK frequency | N/A | 125 | N/A | MHz  |

1. GTX\_CLK is used externally for test purposes only. See signals IEEE\_TEST1\_p and IEEE\_TEST1\_n.



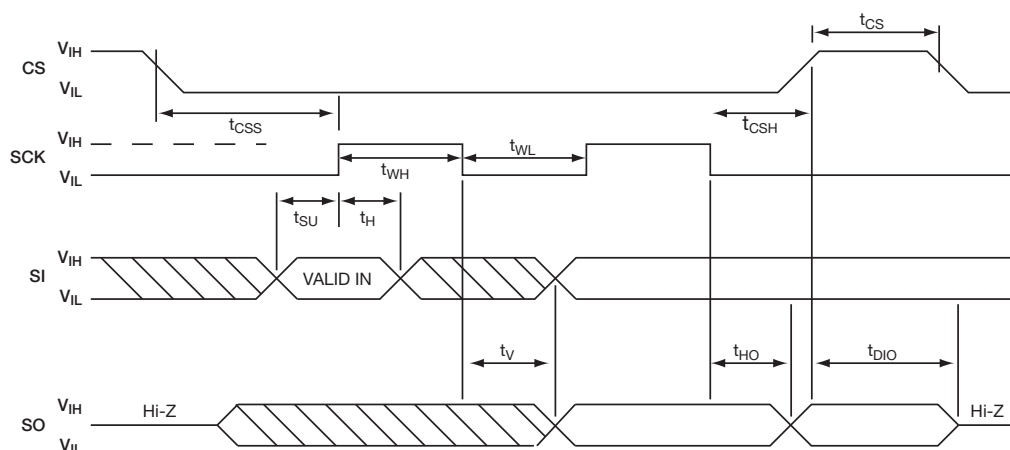
## 6.4.1 EEPROM Interface

Applicable over recommended operating range from  $T_a = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{CC3P3} = 3.3\text{ V}$ ,  $C_{load} = 1\text{ TTL Gate and }16\text{pF}$  (unless otherwise noted).

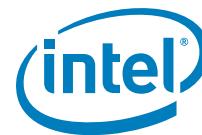
| Symbol           | Parameter           | Min | Typ   | Max | Units | Note |
|------------------|---------------------|-----|-------|-----|-------|------|
| $t_{\text{SCK}}$ | SCK clock frequency | 0   | 2     | 2.1 | MHz   | [1]  |
| $t_{\text{RI}}$  | Input rise time     |     | 2.5ns | 2   | us    |      |
| $t_{\text{FI}}$  | Input fall time     |     | 2.5ns | 2   | us    |      |
| $t_{\text{WH}}$  | SCK high time       | 200 | 250   |     | ns    | [2]  |
| $t_{\text{WL}}$  | SCK low time        | 200 | 250   |     | ns    |      |
| $t_{\text{CS}}$  | CS high time        | 250 |       |     | ns    |      |
| $t_{\text{CSS}}$ | CS setup time       | 250 |       |     | ns    |      |
| $t_{\text{CSH}}$ | CS hold time        | 250 |       |     | ns    |      |
| $t_{\text{SU}}$  | Data-in setup time  | 50  |       |     | ns    |      |
| $t_{\text{H}}$   | Data-in hold time   | 50  |       |     | ns    |      |
| $t_{\text{V}}$   | Output valid        | 0   |       | 200 | ns    |      |
| $t_{\text{HO}}$  | Output hold time    | 0   |       |     | ns    |      |
| $t_{\text{DIS}}$ | Output disable time |     |       | 250 | ns    |      |

**Notes:**

1. Clock is 2MHz
2. 2.50% duty cycle



**Figure 3. EEPROM Interface Time Diagram**

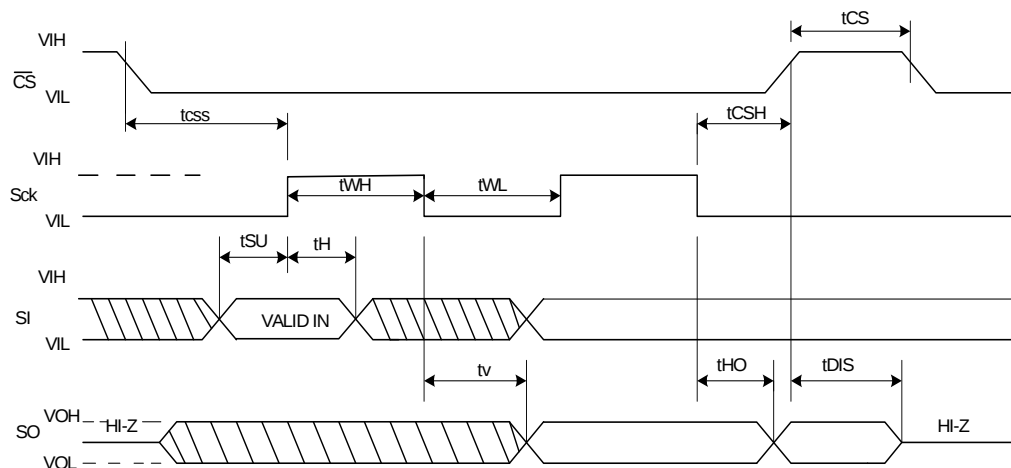


## 6.4.2 FLASH Interface

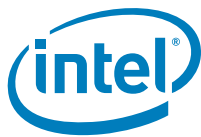
Applicable over recommended operating range from  $T_a = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{CC3P3} = 3.3\text{ V}$ ,  $C_{load} = 1\text{ TTL Gate}$  and  $16\text{ pF}$  (unless otherwise noted)

**Table 15. FLASH Parameters**

| Symbol           | Parameter           | Min | Typ    | Max | Units | Note |
|------------------|---------------------|-----|--------|-----|-------|------|
| $t_{\text{SCK}}$ | SCK clock frequency | 0   | 15.625 | 20  | MHz   | [1]  |
| $t_{\text{RI}}$  | Input rise time     |     | 2.5    | 20  | ns    |      |
| $t_{\text{FI}}$  | Input fall time     |     | 2.5    | 20  | ns    |      |
| $t_{\text{WH}}$  | SCK high time       | 20  | 32     |     | ns    | [2]  |
| $t_{\text{WL}}$  | SCK low time        | 20  | 32     |     | ns    | [2]  |
| $t_{\text{CS}}$  | CS high time        | 25  |        |     | ns    |      |
| $t_{\text{CSS}}$ | CS setup time       | 25  |        |     | ns    |      |
| $t_{\text{CSH}}$ | CS hold time        | 25  |        |     | ns    |      |
| $t_{\text{SU}}$  | Data-in setup time  | 5   |        |     | ns    |      |
| $t_{\text{H}}$   | Data-in hold time   | 5   |        |     | ns    |      |
| $t_{\text{V}}$   | Output valid        |     |        | 20  | ns    |      |
| $t_{\text{HO}}$  | Output hold time    | 0   |        |     | ns    |      |
| $t_{\text{DIS}}$ | Output disable time |     |        | 100 | ns    |      |



**Figure 4. FLASH Timing Diagram**



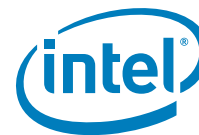
## 6.4.3 NC-SI Interface

Table 16. NC-SI AC Specification

| Symbol | Parameter                                            | Min  | Typ | Max  | Units | Notes |
|--------|------------------------------------------------------|------|-----|------|-------|-------|
|        | REF_CLK Frequency                                    |      | 50  |      | MHz   | 2     |
|        | REF_CLK Duty Cycle                                   | 35   |     | 65   | %     | 1     |
|        | REF_CLK accuracy                                     |      |     | 100  | ppm   |       |
| Tsu    | TXD[1:0], TX_EN, Data Setup to REF_CLK rising edge   | 3    |     |      | ns    |       |
| Thold  | TXD[1:0], TX_EN Data hold from REF_CLK rising edge   | 1.5  |     |      | ns    | 6     |
| Tval   | RXD[1:0], CRS_DV Data valid from REF_CLK rising edge | 1.8  |     | 9    | ns    |       |
| Tor    | RXD[1:0], CRS_DV Output Time rise                    | 0.5  |     | 6    | ns    | 3     |
| Tof    | RXD[1:0], CRS_DV Output Time fall                    | 0.5  |     | 6    | ns    | 3     |
| Todr1  | RXD[1:0], CRS_DV Output delay rise                   | 2    |     | 5.8  | ns    | 3     |
| Todf1  | RXD[1:0], CRS_DV Output delay fall                   | 2    |     | 5.8  | ns    | 3     |
| Tidr2  | TXD[1:0], TX_EN Input delay rise                     | 0.5  |     | 6    | ns    | 4, 5  |
| Tidf2  | TXD[1:0], TX_EN Input delay fall                     | 0.5  |     | 6    | ns    | 4, 5  |
| Tir    | TXD[1:0], TX_EN Input Time rise                      | 0.02 |     | 0.15 | ns    | 4, 5  |
| Tif    | TXD[1:0], TX_EN Input Time fall                      | 0.02 |     | 0.15 | ns    | 4, 5  |

**Notes:**

1. Clock Duty cycle measurement: High interval measured from Vih to Vil points, Low from Vil to next Vih
2. Clock interval measurement from Vih to Vih
3. Cload = 25 pF
4. Cload = 200 fF
5. The input delay test conditions: Maximum input level = VIN = 2.7V; Input rise/fall time (0.2VIN to 0.8VIN) = 1ns (Slew Rate ~ 1.5ns).
6. The NC-SI specification defines a hold time of 1.0 ns. In order to work with the 82575, the board designer should guarantee a hold time of 1.5 ns.



## 6.4.4 SMBus Interface

**Table 17. SMBus AC Characteristics (master mode)**

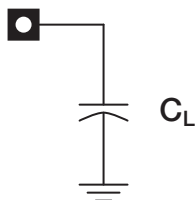
| Symbol        | Parameter                                                                         | Min  | Typ  | Max  | Units   |
|---------------|-----------------------------------------------------------------------------------|------|------|------|---------|
| $F_{SMB}$     | SMBus Frequency                                                                   |      | 74.4 | 100  | kHz     |
| $T_{BUF}$     | Time between STOP and START condition driven by the device                        |      | 6.56 |      | $\mu s$ |
| $T_{HD:STA}$  | Hold time after Start Condition. After this period, the first clock is generated. |      | 6.72 |      | $\mu s$ |
| $T_{SU:STA}$  | Start Condition setup time                                                        |      |      |      | $\mu s$ |
| $T_{SU:STO}$  | Stop Condition setup time                                                         |      | 6.88 |      | $\mu s$ |
| $T_{HD:DAT}$  | Data hold time                                                                    |      | 0.48 |      | $\mu s$ |
| $T_{TIMEOUT}$ | Detect SMBClk low timeout                                                         | 26.2 |      | 31.5 | ms      |
| $T_{LOW}$     | SMBClk low time                                                                   |      | 5.76 |      | $\mu s$ |
| $T_{HIGH}$    | SMBClk high time                                                                  |      | 6.56 |      | $\mu s$ |

**Table 18. SMBus AC Characteristics (slave mode)**

| Symbol        | Parameter                                                                         | Min  | Typ  | Max  | Units   |
|---------------|-----------------------------------------------------------------------------------|------|------|------|---------|
| $F_{SMB}$     | SMBus Frequency                                                                   |      | 74.4 | 100  | kHz     |
| $T_{BUF}$     | Time between STOP and START condition driven by the device                        |      | 6.56 |      | $\mu s$ |
| $T_{HD:STA}$  | Hold time after Start Condition. After this period, the first clock is generated. |      | 6.72 |      | $\mu s$ |
| $T_{SU:STA}$  | Start Condition setup time                                                        |      | TBD  |      | $\mu s$ |
| $T_{SU:STO}$  | Stop Condition setup time                                                         |      | 6.88 |      | $\mu s$ |
| $T_{HD:DAT}$  | Data hold time                                                                    |      | 0.48 |      | $\mu s$ |
| $T_{TIMEOUT}$ | Detect SMBClk low timeout                                                         | 26.2 |      | 31.5 | ms      |
| $T_{LOW}$     | SMBClk low time                                                                   |      | 5.76 |      | $\mu s$ |
| $T_{HIGH}$    | SMBClk high time                                                                  |      | 6.56 |      | $\mu s$ |

**Table 19. AC Test Loads for General Output Pins**

| Symbol | Parameter                | Min | Typ | Max | Unit |
|--------|--------------------------|-----|-----|-----|------|
| $C_L$  | Capacitance of test load | N/A | 16  | N/A | pF   |

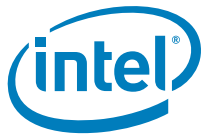
**Figure 5. AC Test Loads for General Output Pins**



## 7.0 Crystal Requirements

**Table 20. Reference Crystal Specification Requirements**

| Parameter Name                            | Symbol               | Recommended Value   | Conditions |
|-------------------------------------------|----------------------|---------------------|------------|
| Frequency                                 | $f_o$                | 25.000 [MHz]        | @25 [°C]   |
| Vibration mode                            |                      | Fundamental         |            |
| Cut                                       |                      | AT                  |            |
| Operating /Calibration Mode               |                      | Parallel            |            |
| Frequency Tolerance @25°C                 | $\Delta f/f_o$ @25°C | ± 30 [ppm]          | @25 [°C]   |
| Temperature Tolerance                     | $\Delta f/f_o$       | ± 30 [ppm]          |            |
| Operating Temperature                     | $T_{opr}$            | -20 to +70 [°C]     |            |
| Non Operating Temperature Range           | $T_{opr}$            | -40 to +90 [°C]     |            |
| Equivalent Series Resistance (ESR)        | $R_s$                | 50 [Ω] maximum      | @25 [MHz]  |
| Load Capacitance                          | $C_{load}$           | 20 [pF] (max 24pF)  |            |
| Shunt Capacitance                         | $C_o$                | 6 [pF] maximum      |            |
| Pullability from Nominal Load Capacitance | $\Delta f/C_{load}$  | 15 [ppm/pF] maximum |            |
| Max Drive Level                           | $D_L$                | 0.5 [mW]            |            |
| Insulation Resistance                     | IR                   | 500 [MΩ] minimum    | @ 100V DC  |
| Aging                                     | $\Delta f/f_o$       | ± 5 [ppm/year]      |            |
| Differential board capacitance*           | $C_D$                | 2 [pF]              |            |
| Board Capacitance                         | $C_s$                | 4 [pF]              |            |
| External Capacitors                       | $C_1, C_2$           | 27 [pF]             |            |
| Board Resistance                          | $R_s$                | 0.1 [Ω]             |            |



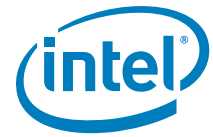
## 8.0 LED Configuration

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The 82575EB provides 4 LEDs per port that may be used to indicate the status of the traffic. The default setup of the LEDs is done via the EEPROM words 1Ch and 1Fh. The default setup for both ports is the same. This setup is reflected in the LEDCTL register of each port. Each driver may change its setup individually. For each of the LEDs the following parameters can be defined:

1. Mode: Defines which information is reflected by this LED. The encoding is described in the LEDCTL register.
2. Polarity: Defines the polarity of the LED.
3. Blink mode: should the LED blink or be stable.

In addition, the blink rate of all LEDs can be defined. The possible rates are 200 ms or 83 ms for each phase. There is one rate for all LEDs



## 9.0 Mechanical Information

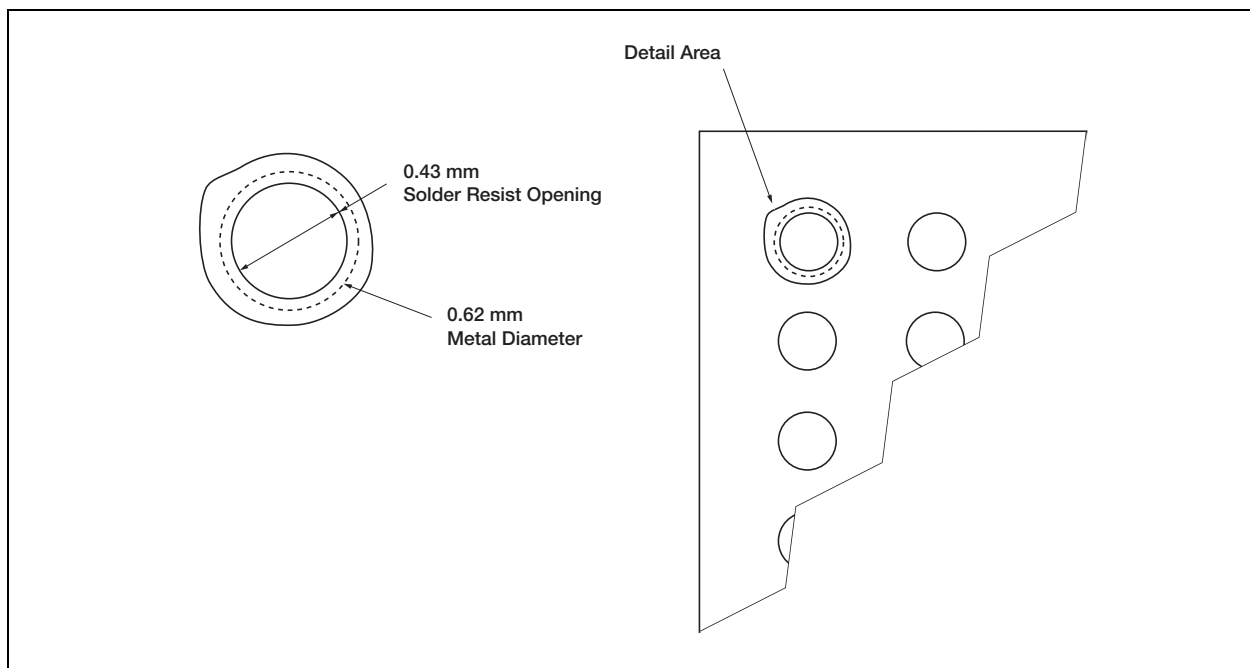
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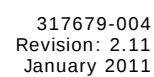
This section describes device physical characteristics.

The targeted signal names are subject to change without notice. Verify with your local Intel sales office that you have the latest information before finalizing a design.

### 9.1 Targeted Package Information

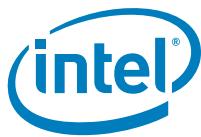
The 82575EB device is a 576-lead flip-chip ball grid array (FC-BGA) measuring 25 mm by 25 mm. The nominal ball pitch is 1 mm. See the data in the printouts below.



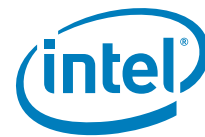




Intel® 82575EB Gigabit Ethernet Controller  
Datasheet  
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|    | 24             | 23             | 22               | 21      | 20            | 19               | 18                | 17     | 16             | 15             | 14              | 13        |
|----|----------------|----------------|------------------|---------|---------------|------------------|-------------------|--------|----------------|----------------|-----------------|-----------|
| AD | VSS            | VSS            | IEEE_T<br>EST1_P | SMBD    | SMBALRT<br>_N | SFP0_I2C_<br>CLK | SFP0_I2C_<br>Data | FLBMD  | FLBSINTCK<br>X | FLSH_SCK       | FLSH_SO         | LED1_0    |
| AC | VSS            | VSS            | IEEE_T<br>EST1_N | SMBCLK  | PE_WAKE<br>_N | SFP1_I2C_<br>CLK | SFP1_I2C_<br>Data | FLBMCK | FLBSD          | FLSH_CE_N      | FLSH_SI         | LED1_2    |
| AB | MDI1_P_0       | MDI1_N_0       | VSS              | VSS     | VSS           | RSVDAB19<br>_NC  | RSVDAB18<br>_NC   | VSS    | VSS            | VSS            | VSS             | VSS       |
| AA | MDI1_P_1       | MDI1_N_1       | VSS              | VSS     | VCC1P8        | VCC1P8           | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| Y  | VSS            | VSS            | RBIAS1<br>_P     | VSS     | VCC1P8        | VCC1P8           | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| W  | MDI1_P_2       | MDI1_N_2       | RBIAS1<br>_N     | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| V  | MDI1_P_3       | MDI1_N_3       | VSS              | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| U  | VSS            | VSS            | VSS              | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| T  | SRDSI_1_<br>N  | SRDSI_1_<br>P  | VSS              | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | VSS             | VSS       |
| R  | SRDSO_1_<br>N  | SRDSO_1_<br>P  | VSS              | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | VCC1P0          | VCC1P0    |
| P  | VSS            | VSS            | VSS              | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | RSVDP<br>_1P014 | VCC1P0    |
| N  | XTAL2          | XTAL1          | VSS              | VCC1P8  | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| M  | RSVDM<br>24_NC | RSVDM<br>23_NC | VSS              | VCC1P8  | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| L  | VSS            | VSS            | SER_<br>RCOMP    | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | RSVDL<br>14_1P0 | VCC1P0    |
| K  | SRDSO_0_<br>N  | SRDSO_0_<br>P  | VSS              | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | VCC1P0          | VCC1P0    |
| J  | SRDSI_0_<br>N  | SRDSI_0_<br>P  | VSS              | VCC1P0  | VCC1P0        | VSS              | VCC1P0            | VCC1P0 | VSS            | VCC1P8         | VSS             | VSS       |
| H  | VSS            | VSS            | VSS              | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| G  | MDI0_P_3       | MDI0_N_3       | VSS              | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VCC1P8         | VSS             | VSS       |
| F  | MDI0_P_2       | MDI0_N_2       | RBIAS0<br>_N     | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| E  | VSS            | VSS            | RBIAS0<br>_P     | VSS     | VCC1P8        | VCC1P8           | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| D  | MDI0_P_1       | MDI0_N_1       | VSS              | VSS     | VCC1P8        | VCC1P8           | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| C  | MDI0_P_0       | MDI0_N_0       | VSS              | VSS     | VSS           | VSS              | VSS               | VSS    | VSS            | VSS            | VSS             | VSS       |
| B  | VSS            | VSS            | IEEE_T<br>EST0_N | EE_CS_N | EE_SK         | LED0_1           | LED0_2            | SDP0_2 | SDP0_1         | SDP0_3         | AUX_PWR         | LAN0_DIS_ |
| A  | VSS            | VSS            | IEEE_T<br>EST0_P | EE_DI   | EE_DO         | LED0_0           | LED0_3            | VCC3P3 | SDP0_0         | LAN1_<br>DIS_N | RSVDA14<br>_NC  | SDP1_2    |
|    | 24             | 23             | 22               | 21      | 20            | 19               | 18                | 17     | 16             | 15             | 14              | 13        |



| 12          | 11         | 10            | 9             | 8           | 7           | 6          | 5           | 4            | 3         | 2         | 1         |    |
|-------------|------------|---------------|---------------|-------------|-------------|------------|-------------|--------------|-----------|-----------|-----------|----|
| VCC3P3      | VSS        | SDP1_0        | RSVDAD9_NC    | RSVDAD8_NC  | JTDI        | VCC3P3     | VSS         | MAIN_PWR_OK  | NCAD3     | VSS       | VSS       | AD |
| LED1_3      | LED1_1     | SDP1_3        | PE_RST_N      | JTDO        | JTMS        | JTCK       | RSVDAC5_3P3 | VSS          | NCAC3     | VSS       | VSS       | AC |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | AB |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PER_3_P   | PER_3_N   | AA |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | Y  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PET_3_P   | PET_3_N   | W  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VCC1P0      | VCC1P0       | VSS       | VSS       | VSS       | V  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VCC1P0      | VCC1P0       | VSS       | PER_2_P   | PER_2_N   | U  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | T  |
| VCC1P0      | VCC1P0     | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PET_2_P   | PET_2_N   | R  |
| VCC1P0      | VCC1P0     | VSS           | VCC1P8        | VCC1P8      | VSS         | VSS        | VCC1P8      | VCC1P8       | VSS       | VSS       | VSS       | P  |
| VSS         | VCC1P0     | VSS           | VCC1P8        | VCC1P8      | VSS         | VSS        | VCC1P8      | VCC1P8       | VSS       | PE_CLK_P  | PE_CLK_N  | N  |
| VSS         | VCC1P0     | VSS           | VCC1P8        | VCC1P8      | VSS         | VSS        | VCC1P8      | VCC1P8       | RSVDM3_NC | RSVDM2_NC | VSS       | M  |
| VCC1P0      | VCC1P0     | VSS           | VCC1P8        | VCC1P8      | VSS         | VSS        | VCC1P8      | VCC1P8       | VSS       | VSS       | PE_RCO_MP | L  |
| VCC1P0      | VCC1P0     | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PER_1_P   | PER_1_N   | K  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | J  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VCC1P0      | VCC1P0       | VSS       | PET_1_P   | PET_1_N   | H  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VCC1P0      | VCC1P0       | VSS       | VSS       | VSS       | G  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PER_0_P   | PER_0_N   | F  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | E  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | PET_0_P   | PET_0_N   | D  |
| VSS         | VSS        | VSS           | VSS           | VSS         | VSS         | VSS        | VSS         | VSS          | VSS       | VSS       | VSS       | C  |
| RSVDB12_3P3 | RSVDB11_NC | RSVDB10_NC    | DEV_OFF_N     | RMII_TXD[0] | RMII_RXD_0  | RMII_TX_EN | RMII_CLK_IN | RMII_CLK_OUT | NCB3      | VSS       | VSS       | B  |
| SDP1_1      | RSVDA11_NC | SRDS1_SIG_DET | SRDS0_SIG_DET | RSVDA8_NC   | RMII_TXD[1] | RMII_RXD_1 | VCC3P3      | RMII_CRD_DV  | VSS       | VSS       | VSS       | A  |
| 12          | 11         | 10            | 9             | 8           | 7           | 6          | 5           | 4            | 3         | 2         | 1         |    |



**NOTE:**      *This page intentionally left blank.*



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